



# PRODUCT SELECTOR GUIDE

December 2023

# Lattice Semiconductor: The Low Power Programmable Leader



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# Lattice Semiconductor: The Low Power Programmable Leader

### Lattice sensAl™ Solution Stack

### Accelerate Integration of Flexible, Ultra Low Power Inferencing

With solutions optimized for ultra low power consumption (under 1 mW - 1 W), small package size (5.5 mm<sup>2</sup> - 100 mm<sup>2</sup>), customizable performance and accuracy, and interface flexibility (MIPI CSI-2, LVDS, GigE, etc.), the Lattice sensAI stack accelerates integration of scalable, always-on, on-device AI.

# Lattice mVision™ Solution Stack

### **Accelerate Implementation of Low Power Embedded Vision Applications**

With solutions optimized for low power consumption ranging from under 150 mW to 1 W and small package size (2.5 x 2.5 mm to 10 x 10 mm) the Lattice mVision solution stack provides customizable performance and flexible interface connectivity (MIPI CSI-2, LVDS, PCIe, GigE, etc.). Lattice's mVision solution stack accelerates the integration of scalable Embedded Vision solutions for Smart Factory, Machine Vision, Smart City, and Smart Home applications.

### Lattice Sentry™ Solution Stack

### Software Solution for Platform Firmware Resiliency (PFR) Root of Trust

The Lattice Sentry solution stack consists of a complete reference platform, fully validated IP building blocks, easy to use FPGA design tools, reference design/demonstrations, as well as a network of custom design services. In many instances, a fully functioning PFR solution can be developed by modifying the included RISC-V C source code.

### Lattice Automate™ Solution Stack

Lattice Automate helps designers accelerate high performance, low power, secure solutions for next generation factory automation solutions. The stack includes modular hardware development boards and software-programmable reference designs and demos that simplify and accelerate implementation of applications like robotics, scalable multi-channel motor control with predictive maintenance, and real-time industrial networking.

### Lattice SupplyGuard™

### **End-to-End Supply Chain Protection Service**

The Lattice SupplyGuard™ service provides customers with factory-locked ICs. These ICs can only be programmed using a configuration bitstream which has been developed, signed and encrypted by the intended customer. The solution is designed to provide protection against counterfeiting, over-building, malware insertion and IP theft.

# General Purpose FPGAs

### Low Power FPGAs (CertusPro-NX, Certus-NX, ECP, and LatticeXP2 families)

Addresses a broad range of connectivity and acceleration applications across multiple markets.

- Lowest power and smallest package with up to 10G SERDES and 100K LCs
- Industry-leading reliability and efficient processing (with class-leading on-chip memory and LPDDR4 support)

### Specialized Families Tailored For Specific Needs

### **Video Connectivity FPGAs (CrossLink Families)**

Optimized for high speed video and sensor applications

- First FPGA with hardened MIPI D-PHY
- Highest performance at lowest power

### **Ultra Low Power FPGAs (iCE40 Families)**

World's lowest power FPGAs; Optimized for small form factor

- Static current as low as 25 uA
- World's most popular ultra low power FPGA

### Control & Security FPGAs (Mach & L-ASC10 Families)

Optimized for platform management & security applications

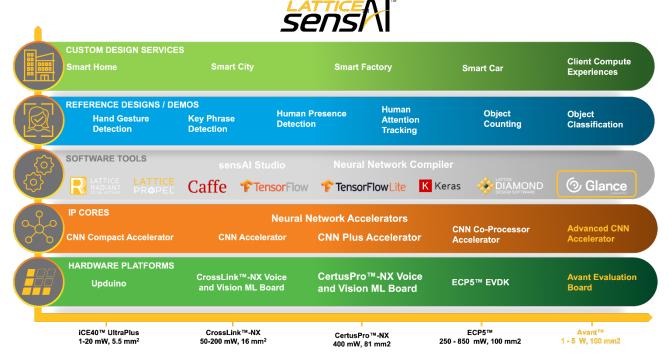
- Instant-on, non-volatile
- Highest I/O density

### Solution Stack - Lattice sens Al

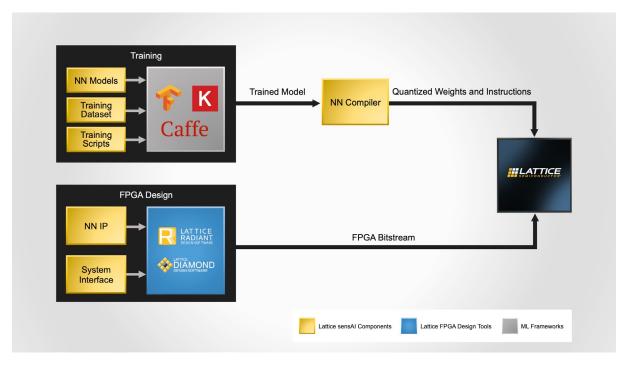
# Ultra Low Power Lattice sensAl™ Stack

## Delivering Milliwatt AI to the Edge with Flexible FPGAs

With solutions optimized for ultra low power consumption (under 1 mW - 1 W), small package size (5.5 mm<sup>2</sup> - 100 mm<sup>2</sup>), customizable performance and accuracy, and interface flexibility (MIPI CSI-2, LVDS, GigE, etc.), the Lattice sensAI stack accelerates integration of scalable, always-on, on-device AI.



Complete technology stack for ultra low power flexible inferencing



Rapid design space exploration - Performance vs Power vs Accuracy tradeoffs

### Solution Stack - Lattice sens Al

### Lattice sensAl Hardware Platforms



### CrossLink-NX VIP Sensor Input Board

- Key Features:
- Seamless connectivity to the Embedded Vision Development Kit
- Optimized for fast prototyping vision-based AI acceleration



### Embedded Vision Development Kit

- Key Features:
- ECP5™ FPGA consuming under 1 W of power consumption
- Supports MIPI CSI-2, eDP, HDMI®, GigE Vision, USB 3.0, etc.



### HM01B0 UPduino Shield

- Key Features:
- A complete development kit for implementing AI using vision and sound as sensory inputs
- iCE40 UltraPlus FPGA based Upduino 2.0 board and HiMax image sensor module

### Lattice sensAIIP Cores

IP Core	OPN	Key Features
CNN Compact Accelerator	CNN-CPACCEL-UP-U	Optimized for iCE40 UltraPlus FPGA, supports variable quantization
CNN Accelerator	CNN-ACCEL-E5-U	Optimized for ECP5 FPGA, supports variable quantization
CNN Plus Accelerator	CNNPLUS-ACCEL-CNX-U	For use with CrossLink-NX FPGA, supports compact and high performance modes

### Lattice sensAl Software Tools

Software Tool	Key Features
Neural Network Compiler	Supports TensorFlow, Keras and Caffe. No prior RTL experience required.

### Lattice sensAl Reference Designs

Reference Design/Demo	Supported FPGA, HW Platform	Power Consumption
Human Face Identification	ECP5, Embedded Vision Development Kit	< 1 W
Object Counting	ECP5, Embedded Vision Development Kit	< 1 W
Object Counting	CrossLink-NX, CrossLink-NX VIP Sensor Input Board	200 mW
Human Presence Detection	iCE40 UltraPlus/HiMax HM01B0 UPduino Shield	< 8 mW
Key Phrase Detection	iCE40 UltraPlus, iCE40 UltraPlus Mobile Development Platform	< 8 mW

### Lattice sensAI Stack Custom Design Services

Have custom Al solution needs? The senseAl stack includes an ecosystem of select, global design service partners that can deliver custom solutions for a range of end applications, including Smart Home, Smart City, Smart Factory, and Smart Cars. Please contact your local sales representative to request more information.

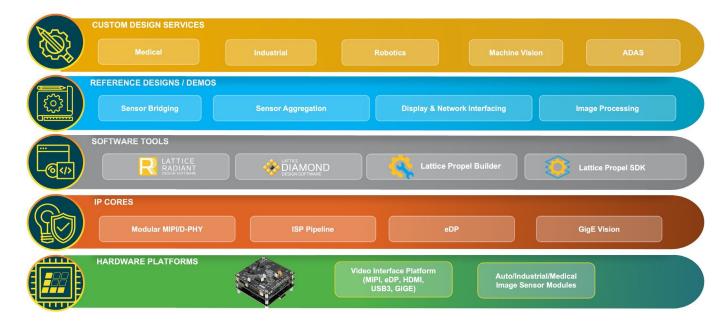
### Solution Stack - Lattice mVision

# Lattice mVision™ Solution Stack

# Accelerate Implementation of Low Power Embedded Vision Applications

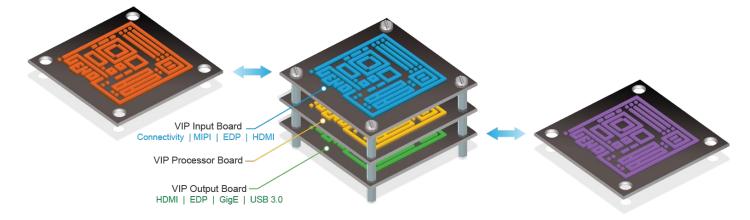
With solutions optimized for low power consumption ranging from under 150 mW to 1 W and small package size (2.5 x 2.5 mm to 10 x 10 mm) Lattice mVision solution stack provides customizable performance and flexible interface connectivity (MIPI CSI-2, LVDS, PCIe, GigE, etc.). Lattice's mVision solution stack accelerates the integration of scalable Embedded Vision solutions for Smart Factory, Machine Vision, Smart City, and Smart Home applications.





### Lattice mVision Hardware Platforms

The Lattice mVision solution stack uses the award-winning Video Interface Platform (VIP) (www.latticesemi.com/vip) which is the ideal hardware for Embedded Vision designs and it provides a highly flexible, smart modular solution for Embedded Vision designers who need to build a prototyping system quickly.



### Solution Stack - Lattice mVision

### Lattice mVision IP Cores

CSI-2/DSI D-PHY Receiver	FPD-LINK Receiver
CSI-2/DSI D-PHY Transmitter	FPD-LINK Transmitter
Byte to Pixel Converter	Color Space Converter
Pixel to Byte Converter	Video Frame Buffer
SubLVDS Image Sensor Receiver	Gamma Corrector
	2D Scaler

### Lattice mVision Partner IP

Helion IONOS Image Signal Processing (ISP)
Bitec DisplayPort IP
Helion GigE Vision IP

### Lattice mVision Design Tools

Lattice's mVision solution stack uses Lattice's standard Radiant and Diamond FPGA design tools for ease of use and fast system design.





### Lattice mVision Reference Designs

N Input to 1 Output MIPI CSI-2 Camera Aggregator Bridge
4 to 1 Image Aggregation with CrossLink-NX
SubLVDS to MIPI CSI-2 Image Sensor Bridge 4 to 1 Image
MIPI DSI/CSI-2 to OpenLDI LVDS Interface Bridge

### Lattice mVision Demonstrations

4 to 1 Image Aggregation Demo for CrossLink-NX Image Input Board	DisplayPort Transmit Demo
2 to 1 side by side Demo for CrossLink on EVDK	Helion GigE Vision
3D Depth-Mapping	IONOS ISP from Helion
Video over USB 3.0	DisplayPort Receive Demo
Video over Ethernet	

### Lattice mVision Custom Design Services

Have custom Embedded Vision solutions needs? The Lattice mVision stack includes an ecosystem of select, global design service partners that can deliver custom solutions for a range of end applications, including Factory, Smart Home, Smart City, and Smart Cars. Please contact your local sales representative to request more information.

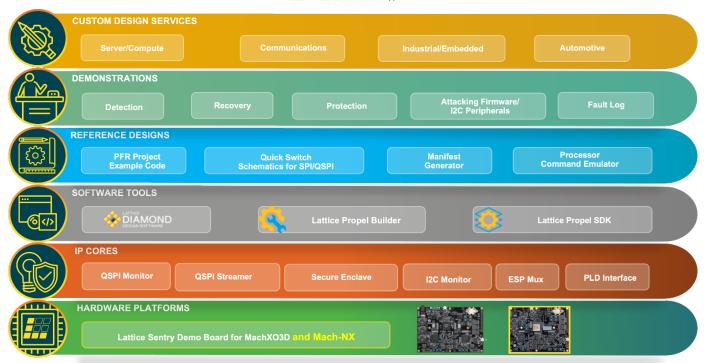
### Solution Stack - Lattice Sentry

# Lattice Sentry™ Solution Stack

Dynamic PFR Solution for Comprehensive Coverage of NIST 800-193 Guidelines

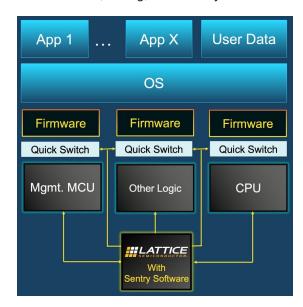
Complete and Easily Configurable PFR RoT





Complete solution toolkit includes everything needed to create a custom Platform Firmware Resiliency (PFR) Implementation

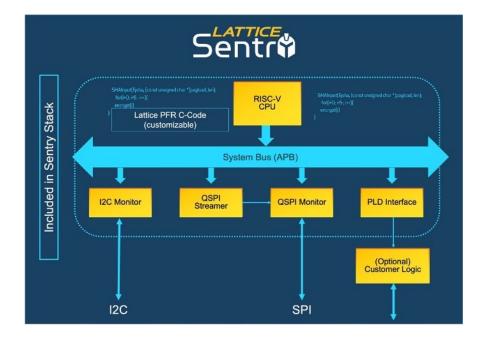
Solution allows secure protection of firmware before, during, and after system boot.



### Solution Stack – Lattice Sentry

### Proven Lattice Sentry IP Cores

- QSPI Streamer
- QSPI Monitor
- I<sup>2</sup>C Monitor
- PLD Interface
- Embedded Security Block Mux
- RISC-V CPU



### Easy To Use Lattice Design Tools





### Plug & Play Lattice Sentry Reference Designs

- PFR Project Example Code
- QuickSwitch Schematics for SPI/QSPI

- Manifest Generator
- Processor Command Emulator

### Instructive Lattice Sentry Demonstrations

- Protection
- Detection
- Recovery

- Attacking Firmware/I<sup>2</sup>C Peripherals
- Fault Log
- Implemented on Lattice Sentry Demo Board for MachXO3D

### Lattice Sentry Custom Design Services

Have customized PFR needs for your design or market? The Lattice Sentry solution is fully customizable, and Lattice has a global Application Services staff who can perform custom IP development if needed. These customizations can enable a resilient PFR solution across a wide range of end applications, including Communications, Industrial, Client Computing, Automotive and Datacenter. Please contact your local Lattice sales agent to request more information.

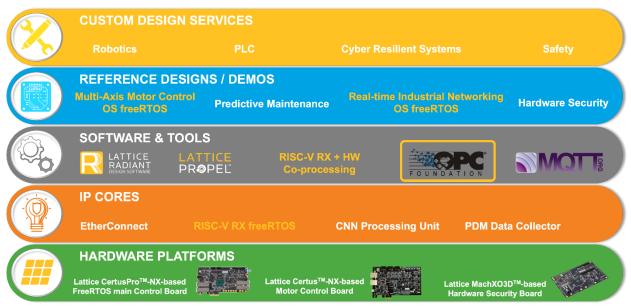
### Solution Stack – Lattice Automate

# Lattice Automate <sup>™</sup> Solution Stack

## Accelerating Factory Automation

Lattice Automate<sup>™</sup> helps designers accelerate high performance, low power, secure solutions for next generation factory automation solutions. The stack includes modular hardware development boards and software- programmable reference designs and demos that simplify and accelerate implementation of applications like robotics, scalable multichannel motor control with predictive maintenance, and real-time industrial networking.





### Hardware Platform

The Lattice Automate solution stack runs on the Certus-NX Versa development board which supports the main processing subsystem, connections to the Host PC, and also the embedded real time Ethernet links. The Motor Control nodes also utilize the Versa board.

### **IP** Cores

- EtherConnect Enables compact, low power, modular real-time sense and control over embedded Ethernet connections
- CNN Processing Unit Provides AI accelerator for Predictive Maintenance processing
- PDM Data Collector Collects data from the Motor Control Nodes for input to the CNN Processing Unit

### **Design Tools**

Lattice's Automate solution stack uses Lattice's standard Radiant and Diamond FPGA design tools and Lattice Propel™, enabling RISC-V based SW and HW co-processing for ease of use and fast system design.







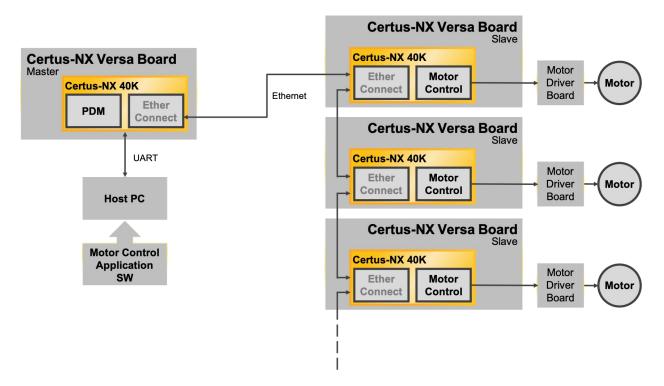
New in Automate 3.0

### Solution Stack - Lattice Automate

### Reference Designs & Demos

Multi-Channel Motor Control with Predictive Maintenance and Embedded Real Time Networking.

- Muti-Channel BLDC Motor Control
- Al enabled support for Predictive Maintenance
- Embedded Real-Time Networking
- GUI for controlling and monitoring the design



### Demo Hardware

- Certus-NX Versa. Platform with 5G PCIe, SGMII, DDR3 Memory and 40k Logic Cells. Main Controller and Nodes use the Certus-NX Versa board.
- Trenz Pmod compatible motor driver board, 15A 0-30V.
- Anaheim Automation BLY17 Series Brushless DC Motor.
- HW RoT Reference Design for Cyber Resiliency using MachXO3D
  - Demonstrate and test the ability to authenticate firmware of protected devices before boot
  - · Detect and block illegal SPI and Flash operations
  - · Automatically replace compromised firmware in the protected subsystem

### Lattice Automate Custom Design Services

Need help putting together solutions for Factory Automation? The Lattice Automate stack includes an ecosystem of select, global design service partners that can deliver custom solutions for a range of end-applications, including factory, smart home, smart city, and smart cars. Please contact your local sales representative to request more information.

# **FPGA Products**

# **General Purpose FPGAs**

	Features		Avant-AT-E			Avant-AT-G		Avant-AT-X			
	Device	E30	E50	E70	G30	G50	G70	X30	X50	X70	
System Logic Ce	lls (k)	262	409	637	262	409	637	262	409	637	
Look-Up-Tables (	k LUTs)	163	255	397	163	255	397	163	255	397	
EBR SRAM	Blocks	400	630	990	400	630	990	400	630	990	
LDR ORAM	Mbits	14.4	22.7	35.6	14.4	22.7	35.6	14.4	22.7	35.6	
Distributed RAM	kbits	1700	2660	4140	1700	2660	4140	1700	2660	4140	
DSP Blocks	18 x 18 Multipliers	700	1120	1800	700	1120	1800	700	1120	1800	
DOI DIOONO	8 x 8 <sup>1</sup> Multipliers	2800	4480	7200	2800	4480	7200	2800	4480	7200	
High Frequency (	Oscillator		1			1			1		
GPLL		7	9	11	7	9	11	7	9	11	
External Memory	Interface	L	PDDR4 / DDF	R4	L	PDDR4 / DDF	R4	LPDD	DR4 / DDR4 /	DDR5	
SerDes Maximum	Speed (Gbps)					12.5		25			
SerDes Protocols	SerDes Protocols				PCle	Gen 1 / 2 / 3,	10GE	PCle Gen 1 / 2 / 3 / 4, 25GE			
Security						eam Encryptic Authenticatior		Avant-G features + User Security			
Temp.	C/I		✓			✓		✓			
0.5 mm Spacing	g (Package type, #Balls, Size)		O (Wide Rang Performance			O (Wide Rang ormance) / Se		Total I/O (Wide Range, High Performance) / SerDes			
ASG (FOWLP)	410 11 x 9 mm	247 (94, 153)			196 (43, 153) / 4			196 (43, 153) / 4			
CSG (FCCSP)	484 12 x 12 mm					218 (43, 175) / 8			218 (43, 175) / 8		
CSG (FCCSP)	841 15 x 13 mm			520 (94, 408)			303 (43, 260) / 8			303 (43, 260) / 8	
0.8 mm Spacin	g (Package type, #Balls, Size)	Total I/	O (Wide Rang Performance	ge, High )		O (Wide Rang ormance) / Se		Total I/O (Wide Range, High Performance) / SerDes			
CBG (FCCSP)	484 19 x 19 mm	329 (94, 235)	329 (94, 235)	349 (94, 255)							
LBG (FCBGA)	484 19 x 19 mm				218 (43, 175) / 8	218 (43, 175) / 8		218 (43, 175) / 8	218 (43, 175) / 8		
1.0 mm Spacin	g (Package type, #Balls, Size)	Total I/	O (Wide Rang Performance	ge, High )		O (Wide Rang ormance) / Se			O (Wide Rang ormance) / Se		
	676 27 x 27 mm			297 (42, 255)	298 (43, 255) / 12	298 (43, 255) / 16	298 (43, 255) / 16	298 (43, 255) / 12	298 (43, 255) / 16	298 (43, 255) / 16	
LFG (FCBGA)	1156 35 x 35 mm			553 (94, 459)			554 (95, 459) / 28			554 (95, 459) / 28	

<sup>1)</sup> One 18 x 18 multiplier fractures into four 8 x 8 multipliers

# **FPGA Products**

### **General Purpose FPGAs**

F	eatures		Certusl	Pro™-NX	Certus™-NX					
	Device		LFCPNX-50	LFCPNX-100	LFD2NX-17 LFD2NX-40					
Logic Cells1 (k)			52	96	17	39				
	Bloc	ks	96	208	24	84				
EBR SRAM	kbits	;	1728	3744	432	1512				
Distributed RAM	kbits	3	344	639	80	240				
	Bloc	ks	4	7	5	2				
Large RAM (LRAM)	kbits	i	2048	3584	2560	1024				
DSP Blocks	18 x	18 Multipliers	96	156	24	56				
PCIe Hard IP			1 (Gen3, 8 Gbps)	1 (Gen3, 8 Gbps)		1 (Gen2, 5 Gbps)				
PCIe Lanes			4	4		1				
SERDES maximum	speed	Gbps	10 <sup>5</sup>	10 <sup>5</sup>		5				
SGMII (1.25 Gbps)	CDR Hard	IP	2	2	2	2				
SGMII (1.25 Gbps) I	anes		2	2	2	2				
GPLL			3	4	2	3				
ADC Blocks			2	2	2	2				
450 MHz High Frequ	uency Osc	cillator	1	1	1	1				
128 KHz Low Powe	r Oscillato	or	1	1	1	1				
DDR Memory Supp	ort (Up to	1066 Mbps)	LPDDR4, LPD	DR2, DDR3/3L	LPDDR2, DDR3/3L					
Boot Flash			Ext	ernal	External					
Dual Boot			,	/	✓					
Multiple Boot			,	/		✓				
Bitstream Encryptic	on (AES-2	56)	,	/	✓					
Bitstream Authentic	cation (EC	DSA)	,	/	<b>✓</b>					
Full-chip Configura	tion Time	² (ms)	29	29	8	14				
I/O Configuration T	ime² (ms)		4	4	3 3					
Core Vcc			1.	0 V	1.0 V					
		С	,	/		✓				
Temp.		ı	,	/		✓				
		A (AEC-Q100)	,	✓	✓					
0.5 mm Spacing (Pa	ckage type	, #Balls, Size)	Total I/O (Wide Range, High Perf	ormance, ADC3) / SERDES Lanes	Total I/O (Wide Range, High Pe	rformance, ADC3) / PCle Lane6				
csfBGA	121	6 x 6 mm			77 (23, 48, 6) / 0	81 (23, 58, 0) / 1				
ASG256	256	9 x 9 mm	165 (75, 84, 6) / 44	165 (75, 84, 6) / 44						
0.8 mm Spacing (Pa	ckage type	, #Balls, Size)	Total I/O (Wide Range, High Perf	ormance, ADC3) / SERDES Lanes	Total I/O (Wide Range, High Pe	rformance, ADC3) / PCle Lane6				
0.8 mm Spacing (Package type, #Balls,		12 x 12 mm				156 (92, 58, 6) / 0				
caBGA	256	14 x 14 mm				191 (111, 74, 6) / 14				
CBG256	256	14 x 14 mm	165 (75, 84, 6) / 44	165 (75, 84, 6) / 44						
BBG484	484	19 x 19 mm	269 (167, 96, 6) / 44	305 (167, 132, 6) / 84						
1.0 mm Spacing (Pa	ckage type	, #Balls, Size)	Total I/O (Wide Range, High Perf	formance, ADC3) / SERDES Lanes	Total I/O (Wide Range, High Pe	rformance, ADC3) / PCle Lane6				
BFG484	484	23 x 23 mm	269 (167, 96, 6) / 4	305 (167, 132, 6) / 4						
LFG672	672	27 x 27 mm		305 (167, 132, 6) / 8						

<sup>1)</sup> Logic Cells = LUTs x 1.2 effectiveness
2) QSPI mode at 150 MHz nominal frequency
3) Each ADC pin count reflects using dedicated complement pair and vRef
4) Available in Automotive Grade
5) 8Gbps for Automotive Grade
6) Each PCle lane consists of a Tx and Rx complement pair

# FPGA Products

# **General Purpose FPGAs**

The color   The	Features		ECP5™-5G ECP5 Automotive					ECP5™						LatticeECP3™							
Formation   For	Device			LFE5UM5G-25	LFE5UM5G-45	LFE5UM5G-85	LAE5UM-25	LAE5UM-45	LAE5U-12	LFE5UM-25	LFE5UM-45	LFE5UM-85	LFE5U-12	LFE5U-25	LFE5U-45	LFE5U-85	LFE3-17EA	LFE3-35EA	LFE3-70EA	LFE3-95EA	LFE3-150EA
Part				24 k	44 k	84 k	24 k	44 k	12 k	24 k	44 k	84 k	12 k	24 k	44 k	84 k	17 k	33 k	67 k	92 k	149 k
California RAM   Ratio   Sample   Sam	EDD CD	# of Blo		56	108	208	56	108	32	56	108	208	32	56	108	208	38	72	240	240	372
Multipliers   Rick   Multipliers   Rick	EDK SKA		kbits	1008	1944	3744	1008	1944	576	1008	1944	3744	576	1008	1944	3744	700	1,327	4,420	4,420	6,850
Max Chan   Max Chan			kbits	194	351	669	194	351	97	194	351	669	97	194	351	669	36	68	145	188	303
SERDES   Max. Rate   5 Gbps   3.2 Gbps			Multipliers	28	72	156	28	72	28	28	72	156	28	28	72	156	24	64	128	128	320
PLL + DLL	SERDE	:s				/4			0	1/2	2				0					2	16
DDR Support					<u> </u>														2 Gbps		
DDR Support	P	PLL + DI	LL			-				2+2	4-	+4	2+2	2+2	4-	+4	2+2	4+2		10+2	
Dual Boot	DE	OR Supp	oort	LPD	DR3 80	0,	LPD	DR3 80	Ο,	DDR3 800, LPDDR3 800, DDR3L 800							DDR3	800, DD	R2 533,	DDR 40	0
Multiple Boot         J </th <th>В</th> <th>Boot Fla</th> <th>sh</th> <th>E</th> <th>xternal</th> <th></th> <th>E</th> <th>xternal</th> <th></th> <th colspan="7">External</th> <th colspan="5">External</th>	В	Boot Fla	sh	E	xternal		E	xternal		External							External				
Bit-stream Encryption		Dual Bo	ot		✓			✓		✓							✓				
Core Vcc	Mι	Multiple Boot			✓			✓		✓											
Temp.	Bit-stre	Bit-stream Encryption			✓			✓		✓							✓				
Temp.   I		Core '	Vcc		1.2 V			1.1 V		1.1 V						1.2 V					
A (AEC-Q100)  0.5 mm Spacing  A (AEC-Q100)  A (AEC-Q100)			С	✓						✓							✓				
1/0 Count   SERDES   1/0 Count   1/0 Count	Temp.		I		✓					✓						✓					
TQFP 144 20 x 20 mm			A (AEC-Q100)	)														/			
TQFP 144 20 x 20 mm	0.5 r	mm Spa	acing			I								I/	O Cour	it / SER	DES				
CaBGA 328 10 x 10 mm	TQFP	144	20 x 20 mm										98/0	98/0	98/0						
1/0 Count   SERDES   1/0 Count   1/0	csfBGA	285	10 x 10 mm	118/2	118/2	118/2				118/2	118/2	118/2	118/0	118/0	118/0	118/0					
256	csBGA	328	10 x 10 mm														116/2				
caBGA         14 x 14 mm         197/2         203/4         205/4         197/2         203/4         197/2         203/4         197/2         203/4         197/2         203/4         205/4         197/2         203/4         205/4         197/2         203/4         205/4         197/2         203/4         205/4         197/2         203/4         205/4         197/2         203/4         205/4         205/4         205/2	18.0	mm Spa	acing			/			1					1/	O Cour	t / SER	DES				
caBGA     554     23 x 23 mm     245/4     259/4     245/4     259/4     245/0     259/0     259/0     365/0       756     27 x 27 mm     365/4     365/4     365/0     365/0       1.0 mm Spacing     I/O Count / SERDES       ftBGA     256     17 x 17 mm     133/4     133/4     133/4       484     23 x 23 mm     222/4     295/4     295/4     295/4     295/4		256	14 x 14 mm										197/0	197/0	197/0						
554   23 x 23 mm   245/4   259/4   245/4   259/4   245/4   259/6   365/0   365/0		381	17 x 17 mm	197/2	203/4	205/4	197/2	203/4	197/0	197/2	203/4	205/4	197/0	197/0	203/0	205/0					
1.0 mm Spacing         I/O Count / SERDES         I/O Count / SERDES           ftBGA         256         17 x 17 mm         133/4         133/4         133/4         222/4         295/4	caBGA	554	23 x 23 mm		245/4	259/4					245/4	259/4			245/0	259/0					
The spacing   Serdes   Serdes   The spacing   Serdes   The space   The space		756	27 x 27 mm			365/4						365/4				365/0					
ftBGA         256         17 x 17 mm         133/4         133/4         133/4         222/4         295/4         295/4         295/4         295/4         295/4	1.0 mm Spacing				/								1/	O Cour	t / SER	DES					
484 23 x 23 mm 222/4 295/4 295/4 295/4 295/4	ftBGA	256	17 x 17 mm	- 3	- NO-S		- 3	11775									133/4	133/4			
																			295/4	295/4	
fpBGA   672   27 x 27 mm   310/4   380/8   380/8   380	fpBGA	672	27 x 27 mm															310/4	380/8	380/8	380/8
	•																				586/16

# **Video Connectivity**

### **CrossLink Series – Embedded Vision FPGAs**

Features				CrossLinkPlus™								
Device			LIF-MD6000-6UWG36	LIF-MD6000-6UMG64	LIF-MD6000-6MG81	LIF-MD6000-6JMG80	LIF-MD6000-6KMG80	LIA-MD6000-6MG81	LIA-MD6000-6JMG80	LIA-MD6000-6KMG80	LIF-MDF6000-6UMG64	LIF-MDF6000-6KMG80
LCs (k)							7				7	7
EBR SRAM	M	Blocks					20				20	20
EBR SRAI	IVI	kbits				1	180				180	180
Distributed	RAM	kbits					47				47	47
		Port	1				2				2	2
MIPI D-PH	ΗY	Lane	4	8	8							
		Max Rate		1.5 Gbps	1.5 Gbps							
GPLL				1	1							
Edge Cloc	:k		2	4	4							
Boot Flash	า			Internal	Internal							
Dual Boot				External	External							
Internal Co	onfiguratio	n Memory		Flash	Flash							
		С	✓									✓
Temp		I		✓							✓	✓
		A (AEC-Q100)						✓	✓	✓		
0.4 mm Pitch		Pitch				I/O (Low Spe	ed/High Speed	d)			1/0 (	L/H)
WLCSP	36	2.5 x 2.5 mm	17/10									
ucfBGA 64		3.5 x 3.5 mm		29/22							29/22	
0.5 mm Pitch					I/O (Low Spe	ed/High Speed	d)			1/0 (	L/H)	
csfBGA 81 4.5 x 4		4.5 x 4.5 mm		37/30 37/30								
	0.65 mm Pitch I/O (Low Speed/High Sp				ed/High Speed	d)			1/0 (	L/H)		
ctfBGA	80	6.5 x 6.5 mm				37/30			37/30			
ckfBGA	80	7 x 7 mm					37/30			37/30		37/30

# **Video Connectivity**

### **CrossLink Series – Embedded Vision FPGAs**

Features				CrossLi	nk™-NX	
Device			LIFCL-17	LIFCL-33	LIFCL-33U	LIFCL-40
LCs (k)			17	33	33	39
EBR SRAM	4	Blocks	24	64	64	84
EBR SRAIV	/I	kbits	432	1152	1152	1512
Distributed	RAM	kbits	80	220	220	240
Large		Blocks	5	5	5	2
Memory (LRAM)		kbits	2560	2560	2560	1024
sysDSP <sup>TM</sup> I	Blocks	18 x 18	24	64	64	56
		Ports	2	-	-	2
MIPI D-PH	Υ	Lanes	8	-	-	8
PCIe (5 Gb	ps)	Lanes	-	-	-	1
USB 2.0 / L	USB 3.2	2 (5 Gbps)	-	-	1/1	-
GPLL			2	1	1	3
Boot Flash				Exte	ernal	
Dual Boot				Exte	ernal	
Multiple Bo	ot			>	X	
Bit-stream I	Encrypt	tion		>	X	
		С	X	x	x	x
Temp		I	X	x	x	x
		A (AEC- Q100)	x			x
	0.4 r	nm Pitch	Tota	ıl I/O (Wide Range, High Performan	nce, ADC¹) (D-PHY Quads², PCIe L	ane³)
WLCSP 72	2 3	.7 x 4.1 mm	45 (15, 24, 6) (1, 0)			
	0.5 r	nm Pitch	Tota	ıl I/O (Wide Range, High Performan	nce, ADC¹) (D-PHY Quads², PCIe L	ane³)
QFN 72	2 1	0 x 10 mm	46 (18, 22, 6) (1, 0)			45 (17, 22, 6) (1, 0)
WLCSP 84	4 3	.1 x 7.3 mm		60 (34 , 26, 0) (0, 0)	44 (17, 27, 0) (0, 0)	
csfBGA 12	21 6	x 6 mm	77 (23, 48, 6) (2, 0)			77 (23, 48, 6) (2, 0)
csBGA 28	89 9	.5 x 9.5 mm				179 (99 , 74, 6) (2, 1)
	0.65	mm Pitch	Tota	ıl I/O (Wide Range, High Performan	ice, ADC¹) (D-PHY Quads², PCIe L	ane³)
fcCSP 10	04 5	.5 x 8.5 mm			52 (20, 32, 0) (0, 0)	
	0.8 r	nm Pitch	Tota	l I/O (Wide Range, High Performan	ice, ADC <sup>1</sup> ) (D-PHY Quads <sup>2</sup> , PCIe L	ane³)
caBGA 25	56 1	4 x 14 mm	77 (23, 48,6) (2, 0)			162 (82, 74, 6) (2, 1)
	00 1	7 x 17 mm				191 (111, 74, 6) (2, 1)

Each ADC pin count reflects using dedicated complement pair and vRef
 Each D-PHY quad consists of 4 D-PHY data lanes
 Each PCIe lane consists of a Tx and Rx complement pair

# **Control and Security**

# MachXO5-NX - Secure, Control Bridging and I/O Expansion FPGAs

	Features			MachXO5™-NX	
	Device		LFMXO5-25	LFMXO5-55T	LFMXO5-100T
Logic Cells <sup>1</sup> (k)			27	53	96
		Blocks	80	166	208
EBR SRAM		kbits	1,440	2,988	3,744
Distributed RAM		kbits	184	320	639
		Blocks	1	5	7
Large RAM (LRAM)		kbits	512	2,560	3,584
Multipliers		18 x 18	20	146	156
PCIe Hard IP			0	1	1
PCle Lanes			0	2	2
SERDES maximum speed		Gbps	0	5	5
SGMII (1.25 Gbps) CDR Hard	IP		2	2	2
SGMII (1.25 Gbps) Lanes			2	2	2
GPLL			2	4	4
ADC Blocks			2	2	2
450 MHz High Frequency Os	cillator		1	1	1
128 KHz Low Power Oscillat	or		1	1	1
DDR Memory Support (Up to	1066 Mbps)		DDR3/3L	DDR3/3L, LPDDR4	DDR3/3L, LPDDR4
Non-Volatile Config Memory	•		Yes	Yes	Yes
On-chip Multi-Boot			3	3	3
User Flash Memory (kb)			9,2162 / 15,3602	56,8322 / 79,8722	56,8322 / 79,8722
Bitstream Encryption			AES-256	AES-256	AES-256
Bitstream Authentication			ECDSA-256	ECDSA-256	ECDSA-256
Core Vcc			1.0 V	1.0 V	1.0 V
		С	✓	✓	✓
Temp.		I	✓	✓	✓
		A (AEC-Q100)			
0.8 mm Spacing (Package type	e, #Balls, Size)		Total I/O (Wide	Range, High Performance) / ADC <sup>3</sup> /	SERDES Lanes
BBG256	256	14 x 14 mm	199 (159, 40) / 6 / 0	-	-
BBG400	400	17 x 17 mm	299 (251, 48) / 6 / 0	291 (159, 132) / 6 / 2	291 (159, 132) / 6 / 2

<sup>1)</sup> Logic Cells = LUTs x 1.2 effectiveness

Initialize 100% of memory / Initialize 0% of memory
 Dedicated inputs for ADC

# **Control and Security**

### Mach-NX & MachXO3/3D - Secure, Control Bridging and I/O Expansion FPGAs

	Featu	es	Mach™-NX	Mach	XO3D™												
	Devid	ce	LFMNX-50	LCMXO3D4300	LCMXO3D-9400	LCMXO3L-640	LCMXO3L-1300	LCMXO3L-2100	LCMXO3L-4300	LCMXO3L-6900	LCMXO3L-9400	LCMXO3LF-640	LCMXO3LF-640 LCMXO3LF-1300 LCMXO3LF-2100 LCMXO3LF-4300				LCMXO3LF-9400
	LUT	s	11280 <sup>8</sup>	4300	9400	640	1300	2100	4300	6900	9400	640	1300	2100	4300	6900	9400
EBR SF	RAM	# of Blocks	48	10	48	7	7	8	10	26	48	7	7	8	10	26	48
	kbits		432	92	432	64	64	74	92	240	432	64	64	74	92	240	432
Distrib.		kbits	73	34	73	5	10	16	34	54	73	5	10	16	34	54	73
UFN		kbits	1064/26694	367/11224	1088/26934							64	64	80	96	256	448
		Memory	Dual Flash	Dual Flash	Dual Flash			Interna							sh		
	Dual B		<b>√</b> 6		6				5						5		
		tion Blocks		), SPI (1), Tin			I <sup>2</sup> C	(2), SPI (	1), Timei	(1)			I <sup>2</sup> C	(2), SPI (	1), Timei	(1)	
Crypto K	Cey Stre	ength (bits)	384	256	256												
		1 V	✓														
Core \	/cc	1.2 V			<b>√</b> 7		_	<b>√</b>						<b>√</b>			
		2.5 - 3.3 V		✓	✓				✓						✓		
Tem	p.	A (AEC- Q100)		✓	✓								`	/			
		С	✓	✓	✓			✓						✓	•		
		ı	✓	✓	✓			<b>√</b>	•					<b>√</b>	•		
0.4	mm Sp	pacing							Total I/0	Os							
	36¹	2.5 x 2.5 mm					28						28				
WLCSP	49¹	3.2 x 3.2 mm						38						38			
	81¹	3.8 x 3.8 mm							63						63		
0.5	mm Sp	acing							Total I/0	Os							
QFN	72	10 x 10 mm		58	58												
	121¹	6 x 6 mm					10	00					1	00			
csfBGA	256¹	9 x 9 mm							206						206		
	324	10 x 10 mm						268	268	281				268 <sup>7</sup>	268 <sup>7</sup>	281	
csBGA	132	8 x 8 mm										1047	1047	1047	104 <sup>7</sup>		
TQFP	100	14 x 14 mm										79 <sup>7</sup>	79 <sup>7</sup>	79 <sup>7</sup>			
0.65	mm S	pacing							Total I/0	Os							
WLCSP	69¹	5.2 x 6.2 mm			58												
0.8	mm Sp	pacing							Total I/0	Os							
	256	14 x 14 mm	188	2067	2067			20	)6 <sup>2</sup>		2063			2067		2062	2063
caBGA	324	15 x 15 mm							279 <sup>2</sup>					27	<b>'</b> 9 <sup>7</sup>	279 <sup>2</sup>	
сарца	400	17 x 17 mm			335				33	35 <sup>2</sup>	335³				33	35 <sup>2</sup>	335³
	484	19 x 19 mm	378		3837						384³						3843

Package is only available for E=1.2 V devices.
 Package is only available for C=2.5 V/3.3 V devices.
 Package is available for both E=1.2 V and C=2.5 V/3.3 V devices.
 When Dual Boot is disabled, image space can be repurposed as extra UFM.

<sup>5)</sup> Dual Boot supported with external boot Flash.
6) Dual Boot is supported by on chip dual configuration flash memory.
7) Available in automotive grade

<sup>8)</sup> Shown in LCs

# **Control and Security**

### MachXO2 & LatticeXP2 Series – Bridging and I/O Expansion FPGAs

	Featur	es				N	lachXO2	тм				ı	LatticeXP	2™		
	Devid	ce	LCMXO2 - 256	LCMXO2 - 640	LCMXO2 - 640U	LCMXO2 - 1200	LCMXO2 - 1200U	LCMXO2-2000	LCMXO2 - 2000U	LCMXO2 - 4000	LCMXO2 - 7000	LFXP2 - 5E	LFXP2 - 8E	LFXP2 - 17E	LFXP2 - 30E	LFXP2 - 40E
	LUT	 S	256	640	640	1280	1280	2112	2112	4320	6864	5 k	8 k	17 k	29 k	40 k
EBR SRAM		# of Blocks	0	2	7	7	8	8	10	10	26	9	12	15	21	48
	kbits		0	18	64	64	74	74	92	92	240		221	276	387	885
Distrib. RAM UFN		kbits kbits	0	5 24	5 64	10 64	10 80	16 80	16 96	34 96	54 256	10	18	35	56	83
sysDSP™		18x18 Blocks Multipliers	0	24	04	04	80	80	90	90	230	3	4 16	5 20	7 28	8 32
PLL+							+2			2+2		2+0			4+0	
DDR S Configuration	upport on Memor				DDR		2 266, LF ternal Fla	DDR266					DDR/2 40 Internal Fla			
	on wemor Boot⁴	у				ın	ternai Fia √	1911				'	memai Fl	asn √		
Bit-stream		1												<b>√</b>		
Embedded Fu	nction Bloc			I <sup>2</sup> C (	2), SPI (1	), Timer (				!						
o v		1.2 V 1.8 - 3.3 V					ZE & HE							✓		
Core Vcc		2.5 - 3.3 V					HC							HC		
		С					<b>√</b>							<b>√</b>		
Temp.		I					✓							✓		
0.4 mm	Spacing	A (AEC-Q100)	,	/									✓			
V. <del></del> IIIIII •	25	2.5 x 2.5 mm				18			18							
									10							
WLCSP	36	2.5 x 2.5 mm				28										
	49 <sup>2</sup>	3.2 x 3.2 mm						38								
	81	3.8 x 3.8 mm								63						
ucBGA	64	4 x 4 mm	44													
0.5 mm	Spacing															
	32	5 x 5 mm	21				21									
QFN	48	7 x 7 mm	40	40												
	84	7 x 7 mm								68						
	100	8 x 8 mm														
csBGA	132	8 x 8 mm	55 <sup>5</sup>	795		104		104		104						
	184¹	8 x 8 mm								150¹						
csfBGA	132	8 x 8 mm										86				
USIDOM	_	14 x 14 mm	55 <sup>5</sup>	785		70		70				00				
TQFP	100		255	103	467	79		79					100			
0.8 mm	144 Spacing	20 x 20 mm			107	107		111		114	114	1	100			
0.0 1111111		14 x 14 mm						206		206	206					
204	256							206		206	206					
caBGA	000									274	278					
	332 Spacing	17 x 17 mm														
1.0 mm	Spacing						206	206		30E	206	172		201		
	Spacing 256	17 x 17 mm					206	206		206	206	172		201		
1.0 mm \$	256 324	17 x 17 mm 19 x 19 mm					206	206				172				
1.0 mm \$	Spacing 256	17 x 17 mm					206	206	278	206	206 334	172		201 358	3 472	63

Contact your Lattice sales representative for the support of the 184-ball csBGA package, available with the HE option only.
 Package is only available for E=1.2 V devices.
 Package is only available for C=2.5 V/3.3 V devices.
 Dual Boot supported with external boot Flash.
 Available in automotive grade

# Ultra Low Power

### iCE40 Series - World's Smallest FPGAs

	Fea	atures	iCE Ultra		iCE4 UltraL		iCE	40 Ultra			i	iCE40 LP	,		iC	E40 HX	
	D	evice	UP3K	UP5K	UL640	UL1K	LP1K	LP2K	LP4K	LP384	LP640	LP1K	LP4K	LP8K	нх1К	HX4K	нх8к
	L	ogic	2800	5280	640	1248	1100	2048	3520	384	640	1280	3520	7680	1280	3520	7680
	N	VCM	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Stat	ic Pov	ver (µA)	75	75	35	35	71	71	71	21	100	100	250	250	296	1140	1140
	E	EBR	80 kb	120 kb	56 kb	56 kb	64 kb	80 kb	80 kb	0	64 kb	64 kb	80 kb	128 kb	64 kb	80 kb	128 kb
	SF	PRAM	0.5 Mb	1 Mb													
	ı	PLL	1	1	1	1	1	1	1			1	2	2	1	2	2
	I <sup>2</sup> C	core	2	2	2	2	2	2	2								
	SP	l Core	2	2			2	2	2								
S	trobe	(low)															
S	trobe	(high)															
Low P	ower	Oscillator	1	1	1	1	1	1	1								
High Fre	quenc	cy Oscillator	1	1	1	1	1	1	1								
2	4 mA	Drive	3	3	3	3	3	3	3		3	33					
100 m <i>A</i>	4 + 400	0 mA Drive			1	1											
50	00 mA	Drive					1	1	1								
Mult 16	x 16, A	Accum 32 bit	4	8			2	4	4								
PW	/M Ge	nerator	Yes	Yes	Yes	Yes	Yes	Yes	No								
0.35	mm S	Spacing							otal I/Os	(Dedicat	ed I/Os)4	5					
	16	1.40 x 1.40 mm									11(1) <sup>1</sup>	11(1) <sup>1</sup>					
WLCSP	16	1.40 x 1.48 mm				10	10										
WLCSP	25	1.71 x 1.71 mm															
	36	2.08 x 2.08 mm					27(1)	27(1)	27(1)								
0.4	mm S	pacing							otal I/Os	(Dedicat	ed I/Os)4	.5					
WLCSP	30	2.15 x 2.55 mm	21	21													
	36	2.5 x 2.5 mm			26	26				27(2)		27(2)1					
	49	3 x 3 mm								39(2)		37(2)1					
ucBGA	81	4 x 4 mm										65(2)	65(2) <sup>2</sup>	65(2) <sup>2</sup>			
uobo, t	121	5 x 5 mm										97(2)	95(2)	95(2)			
	225	7 x 7 mm											180(2)	180(2)			180(2)
0.5	mm S	pacing						1	otal I/Os	(Dedicat	ed I/Os)4	5					
	32	5 x 5 mm								23(2)							
QFN	48	7 x 7 mm		39			39	39	39								
	84	7 x 7 mm										69(2) <sup>1</sup>					
	81	5 x 5 mm										64(2)1					
csBGA	121	6 x 6 mm										94(2)					
	132	8 x 8 mm													97(2)	97(2)	97(2)
VQFP	100	14 x 14 mm													74(2) <sup>1</sup>		
TQFP	144	20 x 20 mm													98(2)	109(2)	
0.8	mm S	pacing							otal I/Os	(Dedicat	ed I/Os)4	5					
caBGA	121	9 x 9 mm															95(2)
Ju 2 3 A	256	14 x 14 mm															208(2)

<sup>1)</sup> No PLL available on the 16 WLCSP, 36 ucBGA, 81 csBGA, 84 QFN and 100 VQFP packages.
2) Only one PLL available on the 81 ucBGA package.
3) 24 mA constant current sink available on the 16 WLCSP package only.
4) Total I/Os include dedicated I/Os.

<sup>5)</sup> Dedicated I/Os are defined to be pins that are dedicated and cannot be used by user logic after configuration.

# **Power and Thermal Management Products**

### Manage power, thermal & control planes in real time

		Power & Thermal Management							
Feat	ures	L-ASC10	LPTM21	LPTM21L					
Voltage Monitoring Inputs		10	10	10					
Current Monitoring Inputs		2	2	2					
Temperature Monitoring Inputs		2	2	2					
Number of Trimming Channels		4	4	4					
MOSFET Drives		4	4	4					
On-Chip Non-Volatile Fault Log		✓	✓	✓					
Number of LUTs			1280	1280					
Distributed RAM (kbits)			10	10					
EBR SRAM (kbits)			64	64					
Number of EBR Blocks (9 kbits)			7	7					
Number of PLLs			1	1					
Number of Macrocells									
Communication I/F		I <sup>2</sup> C	I <sup>2</sup> C/JTAG	I <sup>2</sup> C/JTAG					
Programming Interface		I <sup>2</sup> C	I <sup>2</sup> C/JTAG	I <sup>2</sup> C/JTAG					
Operating Voltage		3.3 V	2.8 V to 12 V	2.8 V to 12 V					
In-system Update Support		✓	✓	✓					
Temp.	I	✓	✓	✓					
remp.	AEC-Q100								
Package Options			Digital I/Os						
48-pin QFN (7 x 7 mm)		95							
237-Ball ftBGA (1 mm) (17 x 17 mm)			95 + 10 <sup>4</sup>						
100-pin TQFP (14 x 14 mm)									
100-Ball caBGA (10 x 10 mm)				32 + 10 <sup>6</sup>					
48-pin TQFP (7 x 7 mm)									
32-pin QFN (5 x 5 mm)									
24-pin QFN (4 x 4 mm)									

<sup>1)</sup> POWR1220AT8 provides 6 (5 V Tolerant) digital inputs and 16 (5 V Tolerant) open-drain digital outputs 2) POWR1014 & PWOR1014A provide 4 (5 V Tolerant) digital inputs and 12 (5 V Tolerant) open-drain digital outputs 3) POWR607 & PWOR605 provide 2 (5 V Tolerant) digital inputs and 5 (5 V Tolerant) open drain I/O 4) LPTM21 provides 95 (3.3 V Tolerant) logic I/Os and 10 (5 V Tolerant) open-drain I/O

<sup>5) 5</sup> V Tolerant open drain I/O 6) LPTM21L provides 32 (3.3 V Tolerant ) logic I/Os and 10 (5 V Tolerant) open-drain I/O

### **IP Cores**

Lattice IP Cores are pre-tested, reusable functions, that allow designers to focus on their unique system architectures. These IP cores provide industry-standard functions such as PCI Express, DDR, Ethernet, CPRI, and embedded microprocessors. In addition, a number of independent IP providers have teamed with Lattice to offer additional high quality, reusable IP cores. Partners are selected for their industry leadership, high development standards, and commitment to customer support. For a complete listing of IP cores from Lattice and its 3rd party partners, please go to *latticesemi.com/IP*. Note that a Radiant or Diamond Subscription License, and the IP license are required to use the IP for production.

	IP Core	Avant-E	CertusPro-NX	Certus-NX	CrossLink-NX	Mach-NX	MachXO5	CrossLink	CrossLinkPlus	iCE40 UltraPlus
	10 Gb Ethernet MAC		✓							
Communications	SGMII and Gb Ethernet PCS	✓	1	✓	✓		✓			
	Triple Speed 10/100/1G Ethernet MAC	1	1	1	1		✓			
	10 Gb Ethernet PCS		1							
	GPIO		1	1	✓					✓
	PCI Express x1 Endpoint		<b>√</b>	1	1					•
Cammantivity.	PCI Express x2 Endpoint		<b>√</b>		•					
Connectivity	PCI Express x4 Endpoint		<b>√</b>							
	PCI Express Root Complex Lite x1			,						
	PCI Express Root Complex Lite x4		<b>√</b>	<b>√</b>	✓					
	USB IP Core		✓							
	CORDIC				<b>√</b>					
	· · · · · ·	✓	<b>√</b>	✓	✓		✓			
Digital Signal	Divider FFT Compiler	<b>√</b>	<b>√</b>	<b>√</b>	<b>√</b>		✓			
Processing	·	✓	<b>√</b>	✓	✓		✓			
	FIR Filter Generator		✓	✓	✓		✓			
	DDR3 SDRAM Controller		✓	✓	✓					
	DDR3 SDRAM PHY		✓	✓	✓					
	I <sup>2</sup> C Master	✓	✓	✓	✓		✓			
	I <sup>2</sup> C Slave	✓	✓	✓	✓		✓			
	I <sup>3</sup> C Controller		✓	✓	✓		✓			✓
Processor,	I <sup>3</sup> C Target		✓	✓	✓		✓			✓
Controller &	LPDDR2 SDRAM Controller Lite		✓	✓	✓					
Peripheral	LPDDR4 SDRAM Controller	✓	✓							
	Scatter Gather DMA		✓	✓	✓		✓			
	SPI Master	✓	✓	✓	✓		✓			
	SPI Slave	<b>√</b>	1	✓	✓		✓			
	UART 16550	✓	1	✓	✓		✓			✓
	Watchdog Timer	<b>√</b>	1	✓	✓		✓			
Neural Network	CNN Plus Accelerator		1	✓	✓					
Accelerators	Compact CNN Accelerator									1
	AHB Lite Interconnect Module			✓	✓	✓				
	AHB Lite to APB Bridge Module			1	1	✓				
	APB Interconnect Module			<b>√</b>	1	√				
	I <sup>2</sup> C Master	✓	✓	<b>√</b>	<b>√</b>	•	✓			✓
Lattice Propel	I <sup>2</sup> C Slave		√	<b>√</b>	<b>√</b>					
Lattice i Topei	I <sup>3</sup> C Controller	•	1	1	<b>√</b>		<b>√</b>			1
	I <sup>3</sup> C Target		1	1	1		<b>√</b>			1
	RISC-V MC CPU IP	✓	1	<b>√</b>	<b>✓</b>	1	<b>√</b>			
	RISC-V SM CPU IP		<b>√</b>							
				<b>√</b>	✓	✓	<b>√</b>			
	SGMII and Gb Ethernet PCS	✓	<b>√</b>	✓	✓		✓			
	System Memory Module		✓	✓	✓	✓				
	UART IP Core			<b>√</b>	✓	✓				
	2D Scaler		√	✓	✓		✓			✓
	4:1 MIPI CSI-2 Bridge							<b>√</b>	<b>√</b>	
	Byte to Pixel Converter	✓	<b>√</b>	✓	✓		✓	✓	✓	
	Color Space Converter	✓	✓	✓	✓		✓			✓
	CMOS to MIPI D-PHY Interface Bridge							✓		
	1:2 and 1:1 MIPI CSI-2 to CSI-2							1	✓	
	Camera Interface Bridge									
	MIPI CSI-2 Bridge							<b>√</b>	<b>√</b>	
	CSI-2/DSI D-PHY Receiver	✓	<b>√</b>	✓	✓		✓	✓	✓	
	CSI-2/DSI D-PHY Transmitter	✓	√	✓	✓		✓	✓	✓	
	Deinterlacer		✓	✓	✓		✓			✓
Video & Imaging	DSI to DSI							✓	✓	
	FPD-LINK Receiver		✓	✓	✓		✓	✓	✓	
	FPD-LINK Transmitter		✓	✓	✓		✓	✓	✓	
	Gamma Corrector	✓	✓	✓	✓		✓			✓
	MIPI D-PHY to CMOS							✓	✓	
	MIPI DSI Bandwidth Reducer Display							✓	1	
	Interface Bridge									
	MIPI DSI to OpenLDI/FPD-Link/LVDS							✓	✓	
	Pixel to Byte Converter	✓	✓	✓	✓		✓			
	SLVS-EC Receiver		✓							
	SubLVDS Image Sensor Receiver	✓	<b>√</b>	✓	✓		✓	✓	✓	
	SubLVDS to MIPI CSI-2							<b>√</b>	1	
	Image Sensor Interface Bridge							<b>√</b>	<b>V</b>	
	Video Frame Buffer		✓	✓	✓					

	IP Core	ECP5/ECP5-5G	ECP3	ECP2M	ECP2	MachXO2	MachXO3D	XP2
	10 Gb Ethernet MAC							
	2.5 Gb Ethernet MAC	1	<b>√</b>	<b>√</b>	<b>√</b>			
	2.5 Gb Ethernet MAC 2.5 Gb Ethernet PCS		<b>√</b>					
	CPRI	<b>√</b>	√ √	1				
0	CPRI 5G	✓ ✓	<b>√</b>	<b>√</b>				
Communications	SPI4	1		1				
	SGMII and Gb Ethernet PCS	1	✓	1	<b>√</b>			1
	Triple Speed 10/100/1G Ethernet MAC	1	✓	1	1			1
	XAUI	1		1	·			·
	JESD204A	•		•				
	JESD204B	1						
	JESD207	1						
	PCI Express x1 Endpoint	1	✓ /	✓				
	PCI Express x2 Endpoint	1						
	PCI Express x4 Endpoint	1	✓	1				
	PCI Express Root Complex Lite x1	1	✓	1				
	PCI Express Root Complex Lite x4	1	✓	1				
	PCI Express x1 Endpoint - Optimized for ECP5UM5G	1						
Connectivity	PCI Express x2 Endpoint - Optimized for ECP5UM5G	1						
	PIPE		✓					
	PCI Master/Target 33		<b>√</b>	✓	✓	✓		✓
	PCI Master/Target 66		✓	1	✓	✓		✓
	PCI Target 33		<b>√</b>	1	1	1		1
	PCI Target 66		<b>√</b>	1	1			1
	Serial RapidIO		✓					
	Tri-Rate Serial Digital Interface (SDI) PHY		✓					
	Block Convolutional Encoder		✓	1				✓
	Block Viterbi Decoder		✓	1				✓
	Cascaded Integrator-Comb (CIC) Filter		✓	✓				✓
	CORDIC	✓	✓	1				✓
	Distributed Arithmetic (DA) FIR Filter		✓	1				✓
	Divider		✓	1				<b>√</b>
Digital Signal	Dynamic Block Reed-Solomon Decoder		✓	<b>√</b>	✓			✓
Processing	FFT Compiler	<b>√</b>	<b>√</b>	<b>√</b>				<b>√</b>
	FIR Filter Generator Interleaver/De-interleaver	1	<b>√</b>	<b>√</b>				<b>√</b>
	Machine Learning for ECP5		<b>√</b>	<b>√</b>				<b>√</b>
	Median Filter	√ √						
	Numerically-Controlled Oscillator (NCO)		<b>√</b>	1				1
	Peak Cancellation Crest Factor Reduction (CFR)	1	✓	· · ·				•
	DDR SDRAM Controller Pipelined			1	<b>√</b>	1		1
	DDR2 SDRAM Controller Pipelined		<b>√</b>	1	1	1		1
	DDR3 SDRAM Contoller	1	✓					-
Processor,	DDR3 SDRAM PHY	1	✓					
Controller &	LPDDR SDRAM Controller					✓		
Peripheral	LPDDR2 SDRAM Controller Lite	✓						
	LPDDR3 SDRAM Controller	1						
	Scatter Gather DMA	✓	✓	✓	✓			✓
Neural Network Accelerators	CNN Accelerator	✓	✓					
	AHB Lite Interconnect Module					✓	✓	
	AHB Lite to APB Bridge Module					1	✓	
	APB Interconnect Module					1	✓	
	EFB Module						✓	
	I <sup>2</sup> C_Monitor						<b>√</b>	
Lattice Propel	QSPI_Master_Streamer						<b>√</b>	
	QSPI_Monitor RISC-V MC CPU IP						<b>√</b>	
	RISC-V MC CPU IP					<b>√</b>	<b>√</b>	
	System Memory Module					\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	<b>√</b>	
	UART IP Core					1	√ √	
	2D Edge Detector		<b>√</b>	1	1		<b>V</b>	<b>√</b>
	2D FIR Filter		✓	<b>√</b>	✓ ✓			<b>√</b>
	2D Scaler	<b>√</b>	✓	✓ ✓	✓ ✓			<b>√</b>
	Color Space Converter	✓ ✓	<b>√</b>	<b>/</b>	✓ ✓	1		<b>√</b>
	Deinterlacer	·		1	<b>√</b>			<b>√</b>
Video & Imaging	Display Interface Mux		·			✓		•
	DVB-ASI		✓					
	Gamma Corrector	✓	<b>√</b>	1	✓			✓
	Median Filter		<b>√</b>	1				1
the state of the s	Video Frame Buffer							

### **Reference Designs**

Lattice Reference Designs are reusable as-is codes that allow designers to quickly build their unique applications. These reference designs provide functions such as 7:1 LVDS, Barcode Emulation, Sensor Interfacing & Preprocessing, I<sup>2</sup>C, SPI, and MIPI solutions. For a complete listing of reference designs from Lattice, please go to: <a href="https://www.latticesemi.com/referencedesigns.">www.latticesemi.com/referencedesigns.</a>

										Forr	nat
Name	Reference Design No.	ECP5/ ECP5-5G	Lattice ECP3	Mach XO3	Mach XO2	Lattice XP2	iCE40 LP/HX	iCE40 Ultra	iCE40 UltraPlus	Verilog	VHDL
7:1 LVDS Video Interface	RD1030	✓	<b>√</b>		<b>√</b>	<b>√</b>				✓	√
8:1 Microphone Aggregation	UG-02035								✓		
8b/10b Encoder/Decoder	RD1012	✓	1	1	1	1				1	1
ADC Interface	RD1089		1							<b>√</b>	1
Audio Interface Bridging	UG-02008								✓		
BSCAN - Multiple Boundary Scan Port Addressable Buffer (BSCAN1)	RD1001				<b>√</b>	✓					
BSCAN - Multiple Boundary Scan Port Linker (BSCAN 2)	RD1002	1			1	✓					
Controller Area Network (CAN) Controller	RD1170						✓			✓	
FPGA Loader	AN8077				1	✓					
GPIO Expander	RD1065		✓			✓				✓	✓
Graphics Acceleration	UG-02026								✓		
HDMI/DVI Interface	RD1097	✓	✓							✓	✓
HiSPi-to-Parallel Sensor Bridge	RD02062	✓	✓	✓	✓	✓				✓	✓
Human Face Identification Using CNN Accelerator IP	RD02062	1								<b>√</b>	
Human Presence Detection Using Compact CNN Accelerator IP	RD02059								✓		
I <sup>2</sup> C Bus Controller for Serial EEPROM	RD1006	✓	✓	✓	✓	✓				✓	✓
I <sup>2</sup> C Master Controller	RD1005	✓	✓	✓	✓	✓				✓	✓
I <sup>2</sup> C Master Controller	RD1139						✓			✓	
I <sup>2</sup> C Master with WISHBONE Controller	RD1046	✓	✓	✓	✓	✓				✓	✓
I <sup>2</sup> C Slave Controller	RD1140						✓			✓	
I <sup>2</sup> C Slave Peripheral Using Embedded Function Block - WISHBONE Compatible	RD1124			✓	✓					✓	✓
I <sup>2</sup> C Slave to SPI Master Bridge	RD1094									✓	✓
I <sup>2</sup> C Slave/Peripheral	RD1054	✓	✓			✓				✓	✓
I <sup>2</sup> C to SPI Bridge	RD1172						✓			✓	✓
I <sup>2</sup> S Controller	RD1101			✓	✓					✓	✓
I <sup>2</sup> S Controller	RD1171						✓			✓	✓
iCE40 Ultra Barcode Emulation Reference Design	UG73							✓	✓	✓	
iCE40 Ultra Pedometer	UG76							✓	✓	✓	
iCE40 Ultra RGB LED Controller	UG75							✓	✓	✓	
iCE40 Ultra Self-Learning IR Remote	UG74							✓	✓	✓	
Key Phrase Detection Using Compact CNN Accelerator	RD02066								✓	✓	
Keypad Scanner	RD1180						✓				✓
LatticeMico32 - Embedded Processor - WISHBONE Compatible		✓	1	✓	1	✓				✓	1
LatticeMico8 - Embedded Processor - WISHBONE Compatible		✓	1	1	1	✓				<b>√</b>	1
LatticeMico8 Microcontroller User's Guide	RD1026			1	1	1				✓	1
LatticeMico8 to WISHBONE Interface Adapter	RD1043					1				✓	✓
LED/OLED Driver	RD1103			✓	1					✓	
LPC Bus Controller	RD1049		✓		✓	✓				✓	✓
MachXO2 Display Interface	RD1093				✓					✓	✓
MachXO2 I <sup>2</sup> C Embedded Programming Access Firmware - WISHBONE Compatible	RD1129				1					<b>√</b>	
MachXO2 Soft I <sup>2</sup> C Slave with Clock Stretching - WISHBONE Compatible	RD1186				1					<b>√</b>	
MDIO Peripheral - WISHBONE Compatible	RD1074		✓							1	1
MIPI CSI-2-to-CMOS Parallel Sensor Bridge	RD1146			✓	✓					<b>√</b>	
MIPI DPHY Interface IP	RD1182	✓	✓	1	<b>√</b>					<b>√</b>	
MIPI DSI RX to Parallel Bridge	RD1185			1	1					1	

Continued on next page

													For	rmat
Name	Reference Design No.	CertusPro- NX	CrossLink	ECP5/ ECP5-5G	Lattice ECP3	Mach XO3/ D	Mach XO2	Mach XO5	Lattice XP2	iCE40 LP/HX	iCE40 Ultra	iCE40 UltraPlus	Verilog	VHDL
MxN Channel PWM	RD1175									√				<b>√</b>
NAND Flash Controller	RD1055						✓		✓				✓	✓
Object Counting Using CNN Accelerator IP Object Counting Using	FPGA-RD-02058			✓									✓	
CNN Plus Accelerator IP	FPGA-RD-02200		✓											
Panasonic Area Sensor- to-Parallel Bridge	RD1121						✓		✓				✓	
Parallel to MIPI CSI-2 TX Bridge	RD1183					1	<b>√</b>						1	
Parallel to MIPI DSI TX Bridge	RD1184					1	<b>√</b>						1	
PCI Target 32 bit/33 MHz	RD1008				1		1		<b>√</b>				1	1
PCI/WISHBONE Bridge – WISHBONE Compatible	RD1045				1				1				√	1
PWM Fan Controller – WISHBONE Compatible	RD1060					1	1		<b>√</b>				1	1
PWM Generator	RD1178									✓				1
RAM-Type Interface														
for Embedded User Flash Memory - WISHBONE Compatible	RD1126						1							
RC4 Based PRNG Generator	RD1179									✓				1
Read and Write Usercode	RD1041					✓	✓						✓	1
RGMII to GMII Bridge	RD1022			✓	✓			1					✓	✓
Sensor Data Buffer	UG-02011											✓		
SD Flash Controller – WISHBONE Compatible	RD1048								✓				✓	✓
SD Host Controller	RD1165									✓			✓	✓
SDR SDRAM Controller SDR SDRAM Controller –	RD1174					✓				✓			✓	
Advanced	RD1010			✓	✓		✓		✓				✓	✓
Simple Sigma-Delta ADC	RD1066						✓		✓				✓	✓
SMPTE SDI Dual HD from/to 3G Level-B Converter	RD1132				✓								✓	
SPI Master Controller	RD1141									✓			✓	
SPI Peripheral	RD1075												✓	<b>√</b>
SPI Slave Controller SPI Slave Peripheral	RD1142									✓			✓	✓
Using the Embedded Function Block - WISHBONE Compatible	RD1125					✓	1						✓	✓
SPI Slave Port Expander	RD1168									✓				✓
SPI to I <sup>2</sup> C Bridge	RD1173									✓			✓	
SPI to MIPI-DSI Bridge SPI to UART Expander	UG-02059 RD1143									<b>√</b>		✓		
SPI Wishbone Compatible						<b>√</b>	<b>√</b>		✓	<b>√</b>			<b>√</b>	✓ ✓
Sub-LVDS Serial to CMOS Parallel Sensor	RD1130						· ✓						√	
Sub-LVDS-to-Parallel Sensor Bridge	RD1122			<b>√</b>	<b>√</b>		<b>√</b>		<b>√</b>				<b>√</b>	<b>√</b>
UART - WISHBONE Compatible	RD1042					<b>√</b>	✓		<b>√</b>				<b>√</b>	<b>√</b>
UART (Universal Asynchronous Receiver/Transmitter)	RD1011							1	<b>√</b>					1
UART 16550 Transceiver	RD1138									✓			<b>√</b>	
LVDS Tunneling Protocol and Interface Reference Design	FPGA-RD-02247					1							·	<b>√</b>
10 Gb Ethernet for MAC & PCS Reference Design Updates	FPGA-RD-02248	✓											<b>√</b>	
SLVS-EC Sensor to PCle Bridge Reference Design	FPGA-RD-02261	✓												✓
Barcode Detection Reference Design – CertusPro	FPGA-RD-02266	1												1
I2C to APB Bridge Reference Design	FPGA-RD-02263					✓	✓						✓	

Lattice Reference Designs are reusable as-is codes that allow designers to quickly build their unique applications. These reference designs provide functions such as I<sup>2</sup>C, SPI, BSCAN and LPC Bus Controller interface solutions. For a complete listing of reference designs from Lattice, please go to: <a href="https://www.latticesemi.com/referencedesigns.">www.latticesemi.com/referencedesigns.</a>

### **Hardware Management Reference Designs**

The attention of the at												
Name	Reference Design No.	MachXO/2/3 L	LatticeXP/XP 2/SC/SC/M/EC	ispMACH 4000ZE/V/B/C /Z	ECP/2/2M/3/ 5	PLATFORM MANAGER/ 2	VHDL	Verilog				
BSCAN - Multiple Boundary Scan Port Addressable Buffer (BSCAN1)	FPGA-RD-02105	✓	✓	✓		✓	✓	✓				
BSCAN - Multiple Boundary Scan Port Linker (BSCAN 2)	FPGA-RD-02106	✓	✓	✓	✓	✓	✓	✓				
FPGA Loader	FPGA-AN-02014	✓	✓		✓		✓	✓				
I <sup>2</sup> C Slave Peripheral Using Embedded Function Block	FPGA-RD-02073	✓					✓	✓				
LPC Bus Controller	FPGA-RD-02114	✓	✓	✓			✓	✓				
MachXO2 I <sup>2</sup> C Embedded Programming Access Firmware	FPGA-RD-02091	✓					✓	✓				
MachXO2 Soft I <sup>2</sup> C Slave with Clock Stretching	FPGA-RD-02092	✓					✓	✓				
NAND Flash Controller	FPGA-RD-02095	✓	✓				✓	✓				
RAM-Type Interface for Embedded User Flash Memory	FPGA-RD-02098	✓					✓	<b>✓</b>				

### iCE40 UltraPlus Single-Wire Signal Aggregation Board

Enables designers to evaluate their single-wire interface to a prototype system to demonstrate a proof of concept in-system.



### eatures

- · No FPGA tools knowledge necessary
- Customizable via available Reference Design
- · Up to 7 channels can be aggregated
- Each channel can be either I2C, I2S or GPIO
- Board set can be configured as a standalone demo or in-system proof of concept

### **Ordering Part Number**

ICE40UP5K-SWA-EVN

### iCE40 UltraPlus Mobile Development Platform

Enables designers to evaluate key connectivity features of the iCE40 UltraPlus FPGA as well as processing features utilizing multiple DSPs, integrated RAM, and FPGA fabric.



### **Features**

- x1 MIPI DSI interface up to 108 Mbps
- 4x Microphone bridging (2x I2S mics and 2x PDM mics)
- Compass sensor (LSM303), pressure sensor (BMP180), gyro sensor (LSM330), and accelerometer (LIS2D12)
- 640 x 480 Image sensor (OVM7692)
- BLE module to transfer any captured data from iCE40 UltraPlus wirelessly

 iCE40 UltraPlus can be programmed via on-board SPI Flash or via USB port

### **Ordering Part Number**

iCE40UP5K-MDP-EVN

### iCE40 UltraPlus Breakout Board

Enables designers to evaluate key connectivity features of the iCE40 UltraPlus FPGA. The breakout board brings out all I/O and allows the FPGA to be programmed over a USB connector.



### **Features**

- iCE40 UltraPlus (iCE40UP5K) device in a 48-pin QFN package
- · High-current LED output
- iCE40UP5K application based current measurements
- Standard USB cable for device programming
- RoHS-compliant packaging and process

- Pre-loaded RGB LED Demo
- Software run GUI
- · USB Connector Cable

**Ordering Part Number** 

iCE40UP5K-B-EVN

### iCE40-HX8K Breakout Board

A simple, low-cost board with an iCE40-HX8K FPGA, and generous I/O access.



### **Features**

- · No FPGA tools knowledge necessary
- Customizable via available Reference Design
- Up to 7 channels can be aggregated
- Each channel can be either I<sup>2</sup>C, I2S or
- Board set can be configured as a standalone demo or in-system proof of concept

**Ordering Part Number** 

iCE40UP5K-SWA-EVN

### iCE40 Ultra Breakout Board

Featuring an ultra-small FGPA optimized for mobile applications. Typical mobile interfaces like RGB, IR and high current Torch LEDs are included, as well as access to every device I/O.



### **Features**

- iCE5LP4K FPGA in 0.35 mm pitch, 36-ball WLCSP
- RGB LED
- · High-brightness "torch" LED
- · Infrared (IR) LED
- · Status LEDs
- · Access to all device I/O
- On-board 32 Mbit SPI Flash for reconfiguration
- Windows- & Mac-based GUI for interface to the RGB LED, includes FPGA source code
- USB Type-A to Type-B (mini) cable for FPGA power and programming via PC

### **Ordering Part Number**

iCE5LP4K-B-EVN

### iCE40 UltraLite Breakout Board

Featuring the world's smallest FGPA optimized for mobile applications. Typical mobile interfaces like RGB, IR and high current Torch LEDs are included, as well as access to every device I/O.



### **Features**

- iCE40UL1K (iCE401K-CM36A) device in a 36-ball BGA package
- Layout example of a board using 0.40 mm pitch BGA package
- High current LED output
- Infrared transmit capability for remote control functions
- iCE40UL1K application-based current measurements
- Standard USB cable for device programming

- RoHS-compliant packaging and process
- Preloaded RGB LED Demo
- · Software-run GUI
- · USB connector cable

### **Ordering Part Number**

iCE40UL1K-B-EVN

### iCE40 Ultra Wearable Development Platform

Peripheral and sensor-rich development platform with iCE40 Ultra and MachXO2 in a wearable watch form factor.



### **Features**

- Approximately (WxLxH) 1.50" x 1.57" x 0.87" form factor with wrist strap
- iCE40 Ultra iCE5LP4K and MachXO2 LCMXO2-2000ZE
- LG 1.54" 240 x 240 single-lane MIPI DSI display
- · Bluetooth low-energy module
- Sensors: Heart-rate/SpO2, skin temperature, pressure and accelerometer/ gyroscope
- 2 user LEDs, RGB LEDs, high-current white LED and high-current IR LED
- Stereo MEMs PDM microphones
- · 32 Mbit Quad SPI-flash
- · 27 MHz Oscillator

- FTDI 2232HQ USB device allows programming of FPGA and Flash
- Reference design available for download:
  - Parallel RGB to MIPI DIS bridging
  - · Health monitoring\*
  - Pedometer\*
  - IR transmitter\*
  - · Flashlight\*
- \* Reference Android APK available to interface with mobile phone over Bluetooth

### **Ordering Part Number**

iCE40UP5K-B-EVN

### iCE40LP1K Evaluation Kit

Featuring our ultra-small FPGA – 1k LUTs in a 16-ball WLCSP package (0.35 mm- ball pitch), only 1.4 mm x 1.48 mm, RGB LED control, GUI available for PC or Mac interface.



### **Features**

- iCE40LP1K in 16-WLCSP package (0.35 mm-ball pitch)
- · High current tri-color LED (RGB)
- · Infrared transmit LED
- · Barcode emulation LED
- · 27 MHz on-board oscillator
- · SMA connector for external clock input
- SPI configuration Flash

- USB Type-A to Type-B (mini) cable for
- FPGA power and programming via

### **Ordering Part Number**

iCE40LP1K-SWG16-EVN

# .

# rossLir

# rossLink-NX

# **Development Kits**

### Himax HM01B0 UPduino Shield

A complete development kit for implementing Artificial Intelligence (AI) using the iCE40 UltraPlus with vision and sound as sensory inputs.



### **Features**

- · Lattice UltraPlus FPGA with 5.3K LUTs,
- · 1 Mb SPRAM, 120 kb DPRAM, 8 Multipliers
- FTDI FT232H USB to SPI Device for FPGA programming
- · 12 MHz Crystal Oscillator Clock Source
- 34 GPIO on 0.1" headers for connecting to the adapter board
- SPI Flash, RGB LED, 3.3 V and 1.2 V voltage regulators
- HM01B0 low power image sensor supports 30 fps at 1.1 mW
- · 2 I2S microphones
- Debug LEDs

### **Ordering Part Number**

HM01B0-UPD-EVN

### CrossLink LIF-MD6000 Master Link Board

Enables designers to streamline the development process and evaluate key connectivity features of the CrossLink FPGA.



### **Features**

- · Contains the Lattice CrossLink
- LIF-MD6000 in 81-ball csfBGA package
- Contains four connectors for interfacing to MIPI D-PHY and high speed programmable I/O
- Includes 0.1" header board, SMA board and LEDs for interfacing and control
- Provides easy programming interface via USB with FTDI device

Ordering Part Number

LIF-MD6000-ML-EVN

### CrossLink LIF-MD6000 I/O Link Boards

Allows designers to easily interface to the LIF-MD6000 Master Link Board from a variety of signal sources and sinks using standard SMA connectors.



### **Features**

- I/O Link Boards for use with Lattice LIF-MD6000 Master Link Board for SMA or low speed peripheral connections
- Contains one SMA board and one 0.1" header board



### **Ordering Part Number**

iCE40UP5K-B-EVN

### **CrossLink-NX Evaluation Board**

Prototyping Board with Abundant I/O, PCIe 5G SERDES, Expansion Headers and 40k Logic Cells.



### **Features**

- CrossLink-NX FPGA (LIFCL-40-9BG400C)
- More I/O access: 118 wide range I/O, 37 high-speed differential pair I/O, one PCle 5G SERDES channel and most configuration pins accessible
- Expandable usability: FPGA Mezzanine Card (FMC), Raspberry Pi, Digilent Peripheral Module (Pmod™), MIPI CSI-2, D-PHY and general purpose I/O expansion headers
- USB-B connection for device programming and Inter-Integrated Circuit (I2C) utility

- On-board Boot Flash: 128 Mbit Serial Peripheral Interface (SPI) Flash, with Quad read feature
- 8 input DIP switches, 4 push buttons,
   3 Status LEDs and 14 LEDs for demo purposes
- · Multiple reference clock sources

### **Ordering Part Number**

LIFCL-40-EVN

### CrossLink-NX PCIe Bridge Board

Enables designers to quickly and efficiently develop designs to bridge a multitude of industry interface I/O standards to PCIe.



### **Features**

- CrossLink-NX FPGA (LIFCL-40-8BG400C/ES2)
- PCle x1 Gen2 supports the Endpoint and Root port configuration
- Supports 1 SFP port on SGMII and 1 Gbit DDR3 Memory
- USB-B connection for device programming and Inter-Integrated Circuit (I2C) utility
- One RJ45 on Ethernet RGMII PHY
- Variable potentiometer and Header for ADC
- Onboard Boot Flash 512 Mbit Serial Peripheral Interface (SPI) Flash with Quad mode support
- · Multiple reference clock sources

### **Ordering Part Number**

LIFCL-PCIEB-EVN

### CrossLink-NX Voice and Vision Machine Learning Board

CrossLink™-NX FPGA board is ideal for machine learning applications and features onboard HyperRAM as well as PMOD (Peripheral Module) connectors for off board support.



- Features
- CrossLink-NX FPGA (LIFCL-40-MG289)
- Contains 4-lane MIPI CSI-2 receiver interface for high resolution camera data
- Supports I2S interface for audio data from two microphones
- Serial interface for low resolution camera data
- SPI flash configuration
- · General Purpose Input/Output

- With 2\*64 Mb HyperRAM available for ML (Machine Learning) applications
- Cypress CYUSB3014 for Video Output to PC over USB3
- 4 PMOD connectors expansion headers available

### **Ordering Part Number**

LIFCL-VVML-EVN

### CrossLink-NX-33 Voice and Vision Machine Learning Board

Designed with low power machine learning applications in mind, using Crosslink-NX 33K, a powerful FPGA with an AI accelerator.



### **Features**

- CrossLink-NX-33 FPGA (LIFCL-33-USG84)
- MIPI CSI-2 receiver (Soft D-PHY) interface for high resolution camera data
- Support I2S interface for audio data from two microphones
- · SPI flash configuration
- · General Purpose Input/Output
- Programming software through USB/FTDI interface (JTAG or SPI)

- Cypress CYUSB3014 for Video Output to PC over USB3
- 1 PMOD connector expansion header available

### Ordering Part Number

LIFCL-33-VVML-EVN

### CrossLinkU-NX Evaluation Board

CrossLinkU-NX Evaluation Board key component is the LIFCL-33U FPGA, which receives input from a camera and sends video output over LIFCL-33U's USB 3.2 interface. This board also features two PMOD (Peripheral Module) connectors for off board support.



### Features

- CrossLinkU-NX FPGA (LIFCL-33U-CTG104)
- Support MIPI CSI-2 receiver (Soft D-PHY) interface for camera data
- SPI flash configuration, 128 Mb QSPI
- Two PMOD expansion headers available and 256 Mb PSRAM Memory
- Supports various onboard interfaces and external interfaces
- Programmed with USB through the FTDI/JTAG interface using Lattice Radiant™ programmer software, or by an external SPI Programmer through header

**Ordering Part Number** 

LIFCL-33U-EVN

### **CrossLink-NX VIP Sensor Input Board**

CrossLink-NX VIP Sensor Input Board, expands multi-sensor connectivity and processing to the Embedded Vision Development Kit..



# Features

- Four on-board Sony IMX 256 image sensors
- Three PMOD connectors for flexible sensor connectivity
- Contains the Lattice CrossLink-NX
- Optimized for easy sensor aggregation
- Supports 4K/2K @60 fps or 1080p @60 fps
- Complements Embedded Vision Development Kit by providing for fast prototyping

**Ordering Part Number** 

LIFCL-VIP-SI-EVN

### **DisplayPort VIP Input Board**

DisplayPort VIP Input Board, expands video connectivity to the Embedded Vision Development Kit with the inclusion of DisplayPort RX and embedded DisplayPort RX.



### **Features**

- Supports DisplayPort 1.4 up to 2.7 Gbps
- Integrated Texas Instruments SN75DP130 DisplayPort 1:1 Redriver
- · Mini DisplayPort (mDP) connector
- Two 60-pin rugged high-speed headers
- Modular Video Interface Platform (VIP) with eDP RX feature support
- Develop custom video interface solutions for embedded vision and machine learning using Lattice Diamond Software

**Ordering Part Number** 

DP-VIP-I-EVN

### **DisplayPort VIP Output Board**

DisplayPort VIP Input Board, expands video connectivity to the Embedded Vision Development Kit with the inclusion of DisplayPort TX and embedded DisplayPort TX.



### **Features**

- Supports DisplayPort 1.4 up to 2.7 Gbps
- Integrated Texas Instruments SN75DP130 DisplayPort 1:1 Redriver
- Mini DisplayPort (mDP) connector
- Two 60-pin rugged high-speed headers
- Modular Video Interface Platform (VIP) with eDP TX feature support
- Develop custom video interface solutions for embedded vision and machine learning using Lattice Diamond Software

Ordering Part Number

DP-VIP-O-EVN

### **Embedded Vision Development Kit**

Embedded Vision Development Kit with dual-camera to HDMI bridging, features CrossLink, ECP5 and Sil1136 devices. The kit's modular platform simplifies development and offers flexibility for design expansion.



### **Features**

- All-inclusive demo system with onboard video sources
- CrossLink LIF-MD6000 input board with two Sony IMX 214 high-speed MIPI D-PHY interface camera sensors
- ECP5 processor board with pre-loaded high-definition Image Signal Processing IP (HD ISP)
- Sil1136, non-HDCP, output board connects any HDMI

- · Includes 0.1" header prototyping
- Easy programming interface via USB with FTDI device
- Modular Video Interface Platform (VIP) allows mixing and matching of input and output boards
- Develop custom video interface solutions for embedded vision and machine learning using Lattice Diamond Software

Ordering Part Number

LF-EVDK1-EVN

### **USB3-GbE VIP IO Board**

USB3-GbE VIP IO Board provides USB 3.1 and Gigabit Ethernet connectivity by converting the output of the ECP5 VIP Processor Board into a standard USB 3.1 and Gigabit Ethernet interface.



### **Features**

- · Two Unified 60-pin high speed connectors
- On board Cypress FX3 USB 3.1 controller
- Compliant with USB 3.1 specification revision 1.0
- · Supports standard USB 3.0 interface
- On board industrial grade TI DP83867IR Gigabit Ethernet PHY
- Supports 10/100/1000 Ethernet

Ordering Part Number

USB3-VIP-EVN

### **Machine Learning Adapter Card**

The Machine Learning Adapter Card adds external memory and microphone input to the ECP5 VIP Processor Board.



- · Includes 8 GB MicroSD card
- Includes Microphone Input
- Easy connection to ECP5 VIP Processor Board, included in Embedded Vision Development Kit



**Ordering Part Number** 

ML-ADP-EVN

### **HDMI VIP Input Bridge Board**

The HDMI VIP Input Bridge Board complements the Embedded Vision Development Kit by providing two selectable HDMI input signals for fast prototyping. The board converts two unencrypted HDMI input video signals into a parallel RGB video format.



### **Features**

- 2 switchable HDMI input signal
- Contains the Lattice Sil1127A
- · Transfer of non-HDCP input data
- Support of 1080p @ 60 Hz HDMIcompliant digital audio and video
- Can be used as stand-alone board or combined with the Embedded Vision Development Kit

**Ordering Part Number** 

HDMI-VIP-IB-EVN

### Lattice USB 3.0 Video Bridge Development Kit

This is a production-ready, high-definition video capture and conversion system, based on the LatticeECP3™ FPGA family.



### **Features**

- Production-ready USB 3.0 audio/video bridging reference design
- 1080p video streaming over USB 3.0 @60 fps
- HDMI 1.4a audio and video capture
- SD-, HD-, 3G-SDI audio and video capture
- Supports video capture from external MIPI CSI-2, SubLVDS or Parallel sensors
- Reference design provides fast USB 3.0 UVC and UAC class data packing
- Plug and play operations as a video capture device on multiple standard platforms (Windows, MacOS, Linux)
- Complete reference design schematics and documentation available

Ordering Part Number

HDMI-VIP-IB-EVN

### Lattice Sentry Demo Boards for MachXO3D and Mach-NX

The Lattice Sentry Demo Board for MachXO3D or Mach-NX lets you develop, demonstrate and test a NIST 800-193-compliant PFR solution on a single board, using the MachXO3D LCMXO3D-9400HC-6BG484C, or Mach-NX LFMNX-50FBG484C as a Platform Root of Trust, and two Lattice ECP5 FPGAs which act as PFR-protected ICs in the system.

### **Features**

- MachXO3D LCMXO3D-9400HC-6BG484C
  - Mach-NX FPGA LFMNX-50FBG484C
- Power Supply (12 V)
- Lattice Sentry Solution Stack PFR demo support
- Lattice Sentry system-level behavior validation
- USB connection for device programming
- Two ECP5 FPGA devices on-board with 256 M SPI/QSPI flash devices to simulate protected external devices





Ordering Part Number	
LCMXO3D-PFR-EVN	
LFMNX-SENTRY-EVN	

### MachXO3L / MachXO3LF Starter Kit

The MachXO3L(F) Starter Kit is a basic breakout board to allow simple evaluation and development of MachXO3L(F) based designs. It includes the LCMXO3L(F)-6900C-5BG256C device.



### **Features**

- MachXO3 FPGA LCMXO3L(F)-6900C-5BG256C
- USB Type-B (mini) connector (program/ power)
- Pre-programmed example design (available on latticesemi.com)
- Eight LEDs
- 4-position DIP switch

- 40-hole prototyping area
- Four 2 x 20 expansion header landings for general I/O, JTAG and external power
- 1 x 8 expansion header landing for JTAG
- 1 x 6 expansion header landing for SPI/ I<sup>2</sup>C
- · SPI Flash for external boot or dual boot
- 3.3 V and 1.2 V supply rails

Ordering Part Number	
LCMXO3L-6900C-S-EVN	
LCMXO3LF-6900C-S-EVN	

### MachXO3L Breakout Board

Focusing on evaluating high-speed source synchronous interfaces with the Lattice MachXO3L-2100 and MachXO3L-6900 products in both 49-ball WLCSP and 256-ball caBGA packages respectively.



### **Features**

- Two MachXO3L FPGAs
  - XO3L-6900E in 256caBGA
  - XO3L-2100E in 49WLCSP
- Two optional configurations:
  - 50-pin Harwin Archer connector for interface to DSI screen (screen not included)
  - 40 SMA connectors for LVDS I/O evaluation
- Generous prototyping/breakout access
- Switches and LEDs for user input and feedback
- Discrete resistors to support SLVS, subLVDS or DPHY Tx, and DPHY Rx, LP mode
- USB Type-A to Type-B (mini) cable for FPGA power and programming via PC
- DC jack for supplemental power input

Ordering Part Number				
MachXO3L SMA Breakout	LCMXO3L-SMA-EVN			
MachXO3L DSI Breakout	LCMXO3L-DSI-EVN			

### MachXO3-9400 Development Board

The MachXO3-9400 Development Board is a full-featured board allowing the evaluation of MachXO3 in hardware management with L-ASC10 and I/O expansion applications utilizing the on-board connectors for Arduino and Raspberry Pi.



### **Features**

**Features** 

- MachXO3LF-9400C-484caBGA and L-ASC10 devices with multiple prototyping and breakout areas
- Arduino and Raspberry Pi development board connectors
- LEDs and switches for demos and evaluation
- On-board FTDI device supports JTAG programming and I2C Interfacing over USB cable
- Footprint support for CrossLink I/O link connectors and ASC expansion board connectors

### Ordering Part Number

LCMXO3LF-9400C-ASC-B-EVN

### **MachXO2 Boards and Kits MachXO2 Breakout Board Features**

- MachXO2 LCMXO2-7000HE
- Access to all device I/O via four 2 x 20 expansion header landings for I/O, JTAG and external power
- 60-hole prototype area
- USB Type-B (mini) connector for power and programming (cable included)
- Eight general purpose LEDs
- 3.3 V and 1.2 V supply rails

### MachXO2 LCMXO2-1200ZE 4-character, 16-segment LCD display 4 capacitive touch sense buttons 1 Mbit SPI Flash I2C temperature sensor

**MachXO2 Pico Development Kit** 

- Current and voltage sensor circuits
- Expansion header for JTAG, I2C
- Standard USB cable for device programming and I2C communication
- RS-232/USB & JTAG/USB interface
- RoHS-compliant packaging and process
- Watch battery



### **MachXO2 Control Development Kit Features**

- MachXO2 LCMXO2-4000HC
- Power Manager II ispPAC-POWR1014A
- 128 Mbit LPDDR memory, 4Mbit SPI Flash
- Current and voltage sensor circuits
- SD memory card socket
- Microphone
- Audio amplifier and Delta-Sigma ADC
- Up to two DVI sources and one DVI output.
- Up to two Display inputs (7:1 LVDS) and one Display output (7:1 LVDS)
- Audio output channel
- Expansion header for JTAG, SPI, I2C and PLD I/O.
- LEDs & switches
- · Standard USB cable for device programming
- RS-232/USB & JTAG/USB interface
- RoHS-compliant packaging and process
- AC adapter (international plugs)

Ordering Part Number				
Breakout Board	LCMXO2-7000HE-B-EVN			
Pico Development Kit	LCMXO2-1200ZE-P1-EVN			
Control Development Kit	LCMXO2-4000HC-C-EVN			



### **MachXO5 Development Board**

The MachXO5-NX Development Board is a full-featured board allowing the evaluation of MachXO5-NX in hardware management and I/O expansion.



### **Features**

- On board MachXO5-25 caBGA Device
- Optional SGMII, Gbe PHY RJ45 connector and Aardvark header
- HyperRAM up to 166 MHz (333 Mbyte/s, x16 bits
- ADC interface with 10K POT
- 7-Segment Blue LED, 4-position DIP Switches, 4 push buttons, and 8 red LEDs for demo
- Two Hirose FX12-40 headers and Multiple reference clock sources
- Versa Headers connection to Lattice L-ASC bridge board

### **Ordering Part Number** LFMXO5-25-EVN

### **MachXO5T-NX Development Board**

The MachXO5T-NX Development Board is a full-featured board allowing the evaluation of LFMXO5-100 in hardware management and PCIe support.



### Features

- Two Gbe PHY RJ45 connectors, with SGMII PHY support
- Supports LPDDR4 upto 1066Mbps, x16 bits
- Supports PCIe Gen2 x1 Edge Connector
- Versa Headers bridge with Lattice ASC Demo Board to support L-ASC10
- General Purpose Input/Output (GPIO) interface with PMOD, Arduino and Raspberry Pi boards

**Ordering Part Number** 

LFMXO5-100T-EVN

### **Certus-NX Versa Evaluation Board**

Connectivity Platform with 5G PCIe, SGMII, DDR3 Memory and 40k Logic Cells.



### **Features**

- Certus-NX FPGA (LFD2NX-40-8BG256C)
- Connectivity platform with 5G PCle and SGMII: PCI Express 2.0 endpoint edge connector (x1 lane), two Gigabit Ethernet ports (one SGMII, one RGMII), DDR3 memory (with 1066 Mbps data rate x 16 data width) and two camera sensors (one using soft D-PHY interface, other using parallel interface)
- Efficient processing and expandable usability: Features Certus-NX low-power general purpose FPGA with 40k logic cells in a 256-BGA package. Board functions expandable via three Digilent
- Peripheral Module (Pmod™) headers available on the board
- USB-B connection for device programming and Inter-Integrated Circuit (I<sup>2</sup>C) utility
- On-board Boot Flash: 128 Mbit Serial Peripheral Interface (SPI) Flash, with Quad read feature
- Four input DIP switches, five push buttons, eight status LEDs and one 7-segment LED for customer purposes
- Multiple reference clock sources

### **Ordering Part Number**

LFD2NX-VERSA-EVN

### **ECP5 Evaluation Board**

Prototyping Board with Abundant Logic, I/O, 5G SERDES and Expansion Headers.



### **Features**

- ECP5-5G FPGA (LFE5UM5G-85F-8BG381)
- More I/O access: 178 I/O (including 20 differential pair I/O), four 5G SERDES, and most configuration pins accessible
- Expandable usability: Arduino, Raspberry Pi, Digilent Peripheral Module (Pmod™), Microphone Daughter Card (MDC) and general purpose I/O expansion headers
- USB-B connection for device programming and Inter-Integrated Circuit (I<sup>2</sup>C) utility and future capability to support Improved Inter-Integrated Circuit (I3C)
- On-board Boot Flash: 128 Mbit Serial Peripheral Interface (SPI) Flash, with Quad read feature
- 8 input DIP switches, 3 push buttons and 8 LEDs for demo purposes
- · Multiple reference clock sources

### **Ordering Part Number**

LFE5UM5G-85F-EVN

### **ECP5 and ECP5-5G Versa Development Kits**

For evaluation and development with the ECP5 and ECP5-5G FPGAs, including PCI Express, Gigabit Ethernet, DDR3 and generic SERDES performance.



### **Features**

- Half-length PCI Express form factor: allows demonstration of PCI Express x1 interconnection
- Electrical testing of one full-duplex SERDES channel via SMA connections
- USB Type-B connection for UART and device programming
- Two RJ45 interfaces to 10/100/1000 Ethernet to RGMII
- On-board boot Flash:128 Mbit Serial SPI Flash
- DDR3-1866 memory components (64 Mbit/x16)

- Expansion mezzanine interconnection for prototyping
- 14-segment alphanumeric display
- Switches, LEDs and displays for demo purposes
- Diamond® programming support
- On-board reference clock sources

### **Ordering Part Number**

LFE5UM-45F-VERSA-EVN

LFE5UM5G-45F-VERSA-EVN

### LatticeECP3 Versa Development Kit

Industry's lowest cost platform for designing PCI Express and Gigabit Ethernet based systems. The kit includes free demos and reference designs.



- The LatticeECP3 Versa Evaluation Board: SERDES Eye Quality Demo
- PCI Express 1.1 x1 Edge connector interface
- Two Gigabit Ethernet ports (RJ45)
- 4 SMA connectors for SERDES access
- USB Type-B (mini) for FPGA programming
- LatticeECP3 FPGA: LFE3-35EA-FF484
- 64 Mbit Serial Flash memory
- 1GB DDR3 Memory
- 14 segment alphanumeric display
- Switches and LEDs for demos

- 4 PCI Express Demos
- Gigabit Ethernet MAC Demo using Mico32
- DDR3 Memory Controller Demo
- Available on Windows and Linux platforms
- USB Type-A to Type-B (mini) cable for FPGA programming via PC
- 12 V AC power adapter and international plug adapters

### **Ordering Part Number**

LFE3-35EA-VERSA-EVN

### **LatticeXP2 Brevia2 Development Kit**

Easy-to-use, low-cost platform for evaluating and designing with Lattice XP2 FPGAs.



- LatticeXP2 FPGA: LFXP2-5E-6TN144C
- 2 Mbit SPI Flash memory
- 1 Mbit SRAM
- Programmed via included mini-USB Cable
- 2 x 20 and 2 x 5 expansion headers
- Push buttons for general purpose I/O and reset
- 4-bit DIP Switch for user-defined inputs
- 8 Status LEDs for user-defined outputs

### **Ordering Part Number**

LFXP2-5E-B2-EVN

### **Platform Manager 2 Development Kit**

The Platform Manager 2 Development Kit is a versatile, ready-to-use hardware platform for evaluating and designing with Platform Manager 2 and L-ASC10 devices. This kit includes a board, programming cable, and assorted example designs and documentation available for download. You can implement and debug your hardware management functions (power, thermal and control plane management) and test them out with this kit.



### **Features**

- LPTM21 (Platform Manager 2 device) & L-ASC10 (Hardware Management expander)
- Temperature monitoring/measurement, with temperature control using fan (included)
- Fault logging under various types of hardware management faults
  - · 4 potentiometers & 2 POLs for sequencing, VID/Voltage scaling, margining, fault creation
- Background programming support with Dual boot from golden image stored on the SPI Flash
- Hardware management expansion through external L-ASC10 boards
- 3-digit LCD for additional code debug support

### L-ASC10 Breakout Board

The L-ASC10 (ASC) Breakout Board is a versatile hardware platform for evaluation and desig with L-ASC10 devices. The board is designed to work alongside the Platform Manager 2 Development Kit.

### **Features**

- · L-ASC10 (Hardware Management Expander)
- 2 potentiometers for sequencing & fault creation
- 9 LEDs for sequencing
- Temperature monitor & measurement with 2 on-board temperature sensors
- Connector for use with Platform Manager 2 Development Kit

Ordering Part Number				
Platform Manager 2 Development Kit	LPTM-BPM-EVN			
L-ASC10 Breakout Board	LPTM-ASC-B-EVN			



### CertusPro-NX Evaluation Board

Prototyping Board with Abundant I/O, SERDES channels, Expansion Headers and 100k Logic Cells.



### **Features**

- CertusPro-NX FPGA (LFCPNX-100-9LFG672C)
- Expandable usability: General purpose Input/Output (GPIO) breakout with FMC connector, PMOD, and Raspberry PI
- Total of 167 wide-range I/O and 132 highspeed differential I/O pairs extended onboard
- Contains 4× SerDes channels with SMA and 4× SerDes channels with HPC connector
- USB-B connection for device programming and Inter-Integrated Circuit Bus (I2C) utility

- With 2.54-mm standard GPIO extended area
- On-board Boot Flash 128 Mb Serial Peripheral Interface (SPI) Flash, with Quad read feature
- · Multiple reference clock sources

### **Ordering Part Number**

LFCPNX-EVN

### CertusPro-NX Versa Board

Enables designers to design and develop solutions with wide range support in MIPI, SFP+, 10 GbE, LPDDR4 and PCIe (Gen3).



### **Features**

- CertusPro-NX FPGA (LFCPNX-100-9LFG672I)
- PCIe x4 Gen3 supports the Endpoint and Root port configuration
- Supports 2×SFP in 10G Ethernet and 1G SGMII
- With 2×SerDes channels with SMA andLPDDR4 DRAM Memory
- On-board Boot Flash 128 Mb Serial Peripheral Interface (SPI) Flash, with Quad read feature
- USB-B connection for device programming and Inter-Integrated Circuit Bus (I2C) utility
- · MIPI CSI-2 Camera connector
- · Multiple reference clock sources

### **Ordering Part Number**

LFCPNX-VERSA-EVN

### CertusPro-NX Voice and Vision Machine Learning Board

CertusPro™-NX FPGA board is ideal for machine learning applications and features onboard HyperRAM as well as PMOD (Peripheral Module) connectors for off board support.



### **Features**

- CertusPro-NX FPGA (LFCPNX-100-BBG484)
- 4-lane MIPI CSI-2 receiver (Soft D-PHY) interface for high resolution camera data
- Support I2S interface for audio data from two microphones
- With 2\*64 Mb HyperRAM available for ML (Machine Learning) applications
- Cypress CYUSB3014 for Video Output to PC over USB3
- 4 PMOD connectors expansion headers available

### **Ordering Part Number**

LFCPNX-VVML-EVN

### CertusPro-NX PCIe Bridge Board

Enables video bridge capabilities to PCIe and embedded vision type applications and offering flexible FMC based Camera, Video or Networking I/O options.



### **Features**

- CertusPro-NX FPGA (LFCPNX-100-9LFG672I)
- Supports PCle x4 Gen3 and LPDDR4 DRAM Memory
- On-board Boot Flash 128 Mb Serial Peripheral Interface (SPI) Flash, with Quad read feature
- · USB 3.0 Controller
- FMC connector

- USB-B connection for device programming and Inter-Integrated Circuit Bus (I2C) utility
- Multiple reference clock sources

### **Ordering Part Number**

LFCPNX-PCIEB-EVN

### **Avant-E Evaluation Board**

Enables designers with rapid prototyping and testing their FPGA designs with FMC HPC, PMOD, and Raspberry PI connectors.



### **Features**

- Avant-E FPGA (LAV-AT-500E-3LFG1156C)
- Expandable usability: General purpose Input/Output (GPIO) breakout with 2 FMC, PMOD, and Raspberry PI connectors
- Total of 95 wide-range I/O and 468 highspeed differential I/O (234 pairs) extended onboard
- USB-B (Mini) connection for device programming
- On-board Boot Flash 512 Mb Serial Peripheral Interface (SPI) Flash, with Single/Dual/Quad support
- 8 input DIP switches, 4 push buttons, 8 green LEDs, 8 red LEDs and 3 seven-segment LEDs for designer configuration
- Two reference clock sources

### **Ordering Part Number**

LAV-500E-EVN

### **Programming Hardware**

### **Programming Cables**

Lattice Programming Cables are used to communicate between a PC and a Lattice device on a target board or system. The most common application is to program a Lattice device. Programming Cables can also be used to help debug your hardware designs via Lattice software tools.

- USB Programming Cable (HW-USBN-2B pictured). The latestgeneration Programming Cable adds I<sup>2</sup>C programming and various other features.
- Parallel Cable (HW-DLN-3C). This connects to a PC parallel port and is best for basic JTAG programming.
- First-generation USB Programming Cable (HW-USBN-2A) The simplest and fastest way to program all Lattice 1.2V, 1.8V, 2.5V, 3.3V, or 5V CPLD and FPGA devices.



Ordering Part Number						
Isp DOWNLOAD Parallel Cable	HW-DLN-3C					
First Programming Cable	HW-USBN-2A					
USB Programming Cable	HW-USBN-2B					

### **Smart Sockets**

Lattice Smart Sockets are an all-in-one solution for prototype programming of the latest Lattice products.

These complete solutions include all the functionality of a Desktop Programmer + Socket Adapter combination in a single board. All that's needed is a simple connection to your PC via USB (cable included).

More information about Lattice Smart Sockets is on the Lattice website at www.latticesmi.com/sockets.



# Model 300 From ammer

Ordering Part Number					
Model 300 Desktop Programmer	PDS4 102-PM300N				
iCEprog Desktop Programmer	ICEPROGM1050-01				

### **Desktop Programmers**

Lattice offers two desktop programmers for prototype programming of Lattice products.

A Socket Adapter is required for the specific device/package you wish to program. These are available separately, and are designed specifically for one Desktop Programmer or the other.

The Lattice Model 300 Desktop Programmer (pictured) supports most Lattice FPGA and CPLD products.

The iCEprog Desktop Programmer supports all Lattice iCE products.



Lattice Socket Adapters are used in conjunction with a Lattice Desktop programmer to facilitate low-volume, manual programming of Lattice devices.

Socket adapters are generally designed to support a device family/package combination.

iCE Socket Adapters work only with the iCEprog Desktop Programmer. All other Lattice Socket Adapters work only with the Model300 Desktop Programmer.

More information and a complete list of Lattice Socket Adapter products is available at www.latticesmi.com/sockets.



# FPGA and CPLD Design Software

Best in Design		Lattice Radiant (Subscription)	Lattice Radiant (Free)	Lattice Diamond™ (Subscription)	Lattice Diamond™ (Free)	ispLEVER™ Classic (Subscription)	iCEcube2™ (Free)	PAC- Designer (Free)	Lattice Propel (Free)
	Avant-E	✓							✓
	MachXO5-NX	✓							✓
	CertusPro-NX	✓							✓
	Certus-NX	✓	✓						✓
	CrossLink			✓	✓				
	CrossLinkPlus			✓	✓				
	CrossLink-NX	<b>√</b>	✓						
	ECP5UM5G			✓					
	ECP5U			✓	✓				
	ECP5UM			<b>√</b>					
Device	LatticeECP3			<b>√</b>					
Families	LatticeECP2M/S			<b>√</b>					
	LatticeECP2S			<b>√</b>					
	MachXO/XO2/XO3			<b>√</b>	<b>√</b>				
	MachXO3D			<b>√</b>	<b>√</b>				1
	Mach-NX			<b>√</b>	<b>√</b>				<b>√</b>
	LatticeXP2			<b>/</b>	<b>√</b>				
	LatticeECP2			<b>√</b>	✓				
	iCE40	<b>√</b>	1				✓		
	iCE40 UltraPlus	•	<b>V</b>			<b>√</b>			
	ispMACH 4000B/C/V/ZE			,					
	Platform Manager 2 L-ASC10			<b>√</b>	✓ ✓				
				<b>V</b>	<b>V</b>				
	Power Manager II							✓	
	Design Exploration	<b>√</b>	<b>√</b>	1	<b>√</b>		✓		
	VHDL & Verilog Support	<b>√</b>	<b>√</b>	<b>√</b>	<b>√</b>	<b>√</b>	✓		
	Schematic Support	<b>√</b>	<b>√</b>	1	<b>√</b>	<b>√</b>			
	ABEL					✓		✓	
	Synopsys∘ Synplify Pro™ for Lattice-Synthesis	✓	✓	✓	✓	✓			
Software	Lattice Synthesis Engine (LSE)	FPGA only	FPGA only	MachXO/XO2/ XO3/XO3D Lattice ECP2/ ECP3/ECP5/ ECP5-5G/ ECP2M/XP2	MachXO/XO2/ MachXO3/XO3D LatticeECP2/ ECP5U/XP2	ispMACH 4000 only	✓		
Features	Embedded Security Block			FPGA only					
	Security / Encrypted Bit-Stream		CrossLink-NX	✓					
	IP and Module Configuration	✓	✓	✓	✓	Module Only	Module Only		
	Power Estimation & Calculation	✓	✓	✓	✓		✓		
	Propel Builder								✓
	Propel SDK								✓
	Timing Analysis	✓	✓	✓	✓	✓	✓		
	Floorplanning	✓	✓	✓	✓	✓	✓		
	On-Chip Debug	✓	✓	1	✓	ispXPGA Only			
	TCL Scripting Dictionaries	✓	✓	✓	✓				
	Mentor ModelSim® Lattice FPGA Edition	✓	✓	✓	✓	✓	✓		
	Windows (64 bit)	Window		Windows 10		Window			Windows 10
Operating	Linux	RHEL v7.7	7 and v8.4	RHEL v	6 and v7		RHEL v6		RHEL v7.7 and v8.4
Systems	Ubuntu	v10.08 and	v20.04 LTS						v20.04 LTS
Licensing &	License Terms	One Year, Renewable	One Year , Renewable	One Year, Renewable	One Year, Renewable	One Year, Renewable	One Year, Renewable		One Year, Renewable
Updates	Node-Locked License	√ √	✓ ✓	√	√	√ √	√		√
	Floating License	<b>√</b>	√ ·	✓	√ ·	√ ·			



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